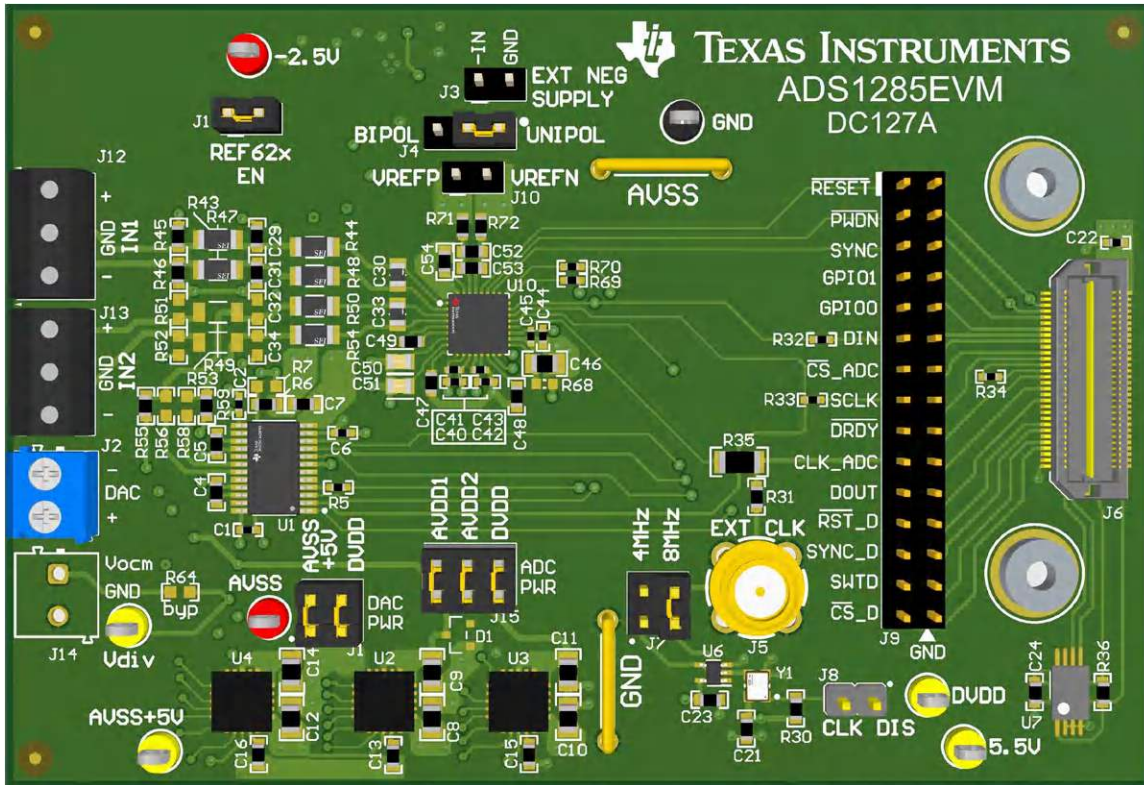


Cole Macias

ABSTRACT



This user's guide describes the characteristics, operation, and use of the ADS1285EVM-PDK. This evaluation module (EVM) is an evaluation board for the [ADS1285](#), a high-performance, 32-bit, multichannel, delta-sigma ($\Delta\Sigma$) analog-to-digital converter (ADC). The EVM allows evaluation of all aspects of the ADS1285. This manual covers the operation of the ADS1285EVM-PDK. Throughout this document, the terms *evaluation board*, *evaluation module*, and *EVM* are synonymous with the ADS1285EVM-PDK. Complete circuit descriptions, schematic diagrams, and bills of material are included in this document.

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1 EVM Overview

The evaluation kit includes the ADS1285EVM-PDK board and the precision host interface (PHI) controller board. The PHI board enables the accompanying computer software to communicate with the ADC over the universal serial bus (USB) for data capture and analysis because the ADS1285EVM-PDK does not contain a microprocessor on the board.

The PHI board primarily serves three functions:

- Provides a communication interface from the EVM to the computer through a USB port
- Provides the digital input and output signals necessary to communicate with the ADS1285EVM-PDK
- Supplies power to all active circuitry on the ADS1285EVM-PDK board

The following related documents are available for download through the Texas Instruments web site at www.ti.com.

Table 1-1. Related Documentation

Device	Literature Number
ADS1285	SBASAK6

1.1 ADS1285EVM-PDK Kit

The ADS1285 evaluation module kit includes the following features:

- Contains all support circuitry needed for the ADS1285
- USB powered: No external power supply is required
- Voltage reference options: External or onboard
- Clock options: External clock source or 8.192-MHz onboard crystal oscillator with dividers for 4.096-MHz
- Voltage supply options: Unipolar or bipolar support with adjustable AVDD1 low-dropout regulator (LDO) and externally sourced -2.5 -V LDO
- Signals contained within signal bank for ease of probing
- Built-in analysis tools including scope, FFT, histogram, and DAC configuration using the graphical user interface (GUI)

2 ADS1285EVM-PDK Quick-Start Guide

The following instructions are a step-by-step guide to connecting the ADS1285EVM-PDK to the computer and evaluating the performance of the ADS1285:

1. Review the default jumper settings in [Section 7](#) and GUI software installation in [Section 7.2](#).
2. Connect the ADS1285EVM-PDK to the PHI. Install the two screws as indicated in [Figure 2-1](#).
3. Attach the micro USB to the PHI board and your PC. Three LEDs illuminate on the PHI board to indicate connectivity to the PC.
 - a. LED D5 on the PHI lights up, indicating that the PHI is powered up.
 - b. LEDs D1 and D2 on the PHI start blinking to indicate that the PHI is booted up and communicating with the PC. [Figure 2-1](#) shows the resulting LED indicators.



Figure 2-1. ADS1285EVM-PDK Hardware Setup and LED Indicators

4. Launch the ADS1285EVM-PDK GUI software and power will be supplied to the EVM.
 - a. The default installation path is `C:\Program Files (x86)\Texas Instruments\ADS1285 EVM`.
5. As shown in [Figure 2-2](#), use the *Configuration* section of the GUI for a specific clock input, desired data rate, and number of samples. Then, use the **Capture** button to collect data. [Section 8.1](#) details the EVM GUI global input parameters and the various pages within the GUI.

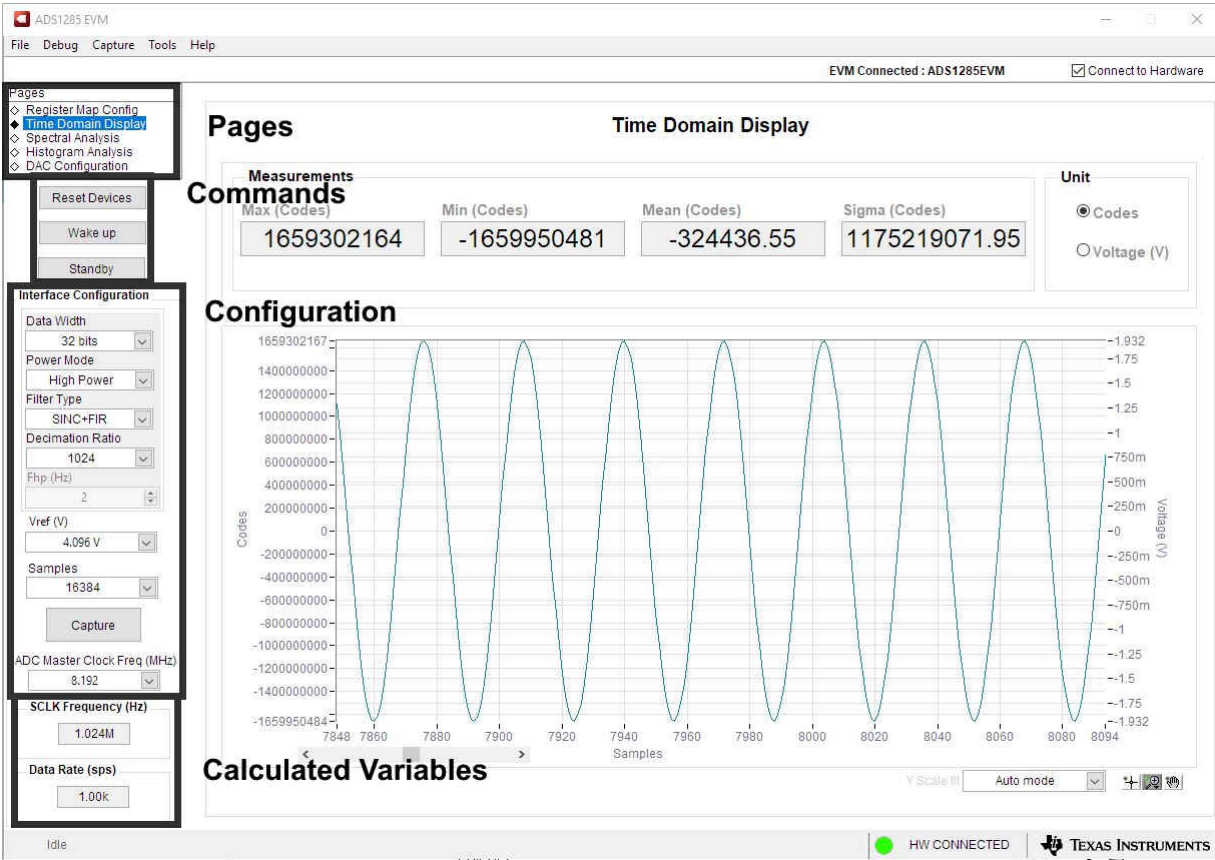


Figure 2-2. EVM GUI Global Input Parameters

3 EVM Analog Interface

The ADS1285EVM-PDK is designed for easy interfacing with analog sources. This section details the front-end circuit, including jumper configuration for different input test signals and board connectors for signal sources.

3.1 ADC Analog Input Signal Path

Analog inputs to the EVM can be connected to either terminal block associated with each ADC channel. The screw terminal blocks (J12, and J13) can interface directly with the leads of an external sensor input. [Figure 3-1](#) depicts the signal chain used for the two input channels on the EVM and [Table 3-1](#) lists the supported input options.

An input must not be applied such that the voltage on the input pins of the ADS1285 exceeds the absolute maximum ratings. For more details, see the [ADS1285 data sheet](#).

R45 and R46 provide common-mode voltage paths for the channel 1 inputs. See [Section 5](#) for more information. In addition, R43 and C29 (in combination with R47 and C31) provide the common-mode, low-pass filters for the positive and negative inputs, respectively. Furthermore, R44 and R40 in combination with C30 provides the differential low-pass filter used in antialiasing. The series impedance is kept relatively low to maintain adequate total harmonic distortion (THD) performance. Similar differential and common-mode, low-pass filter footprints are present on all inputs.

Specifically for channel 2, the default configuration is set up to use the [DAC1282](#) on the input. As a result, the common-mode filters for this configuration are not populated, and R50, R54, and C33 are optimized for the output of the DAC. There are two options for connecting the DAC to the channel 2 of the ADS1285: using the direct output of the DAC1282 or the integrated switches of the DAC1282. By default, the direct output of the DAC1282 is used by populating R55 and R59. As a result, using the integrated switches is achieved by depopulating R55 and R59, populating R56 and R58, and configuring the DAC using the GUI as described in [Section 6](#). For best THD performance (approximately a 1-dB difference), use the direct output. For maximum flexibility, use the integrated switches.

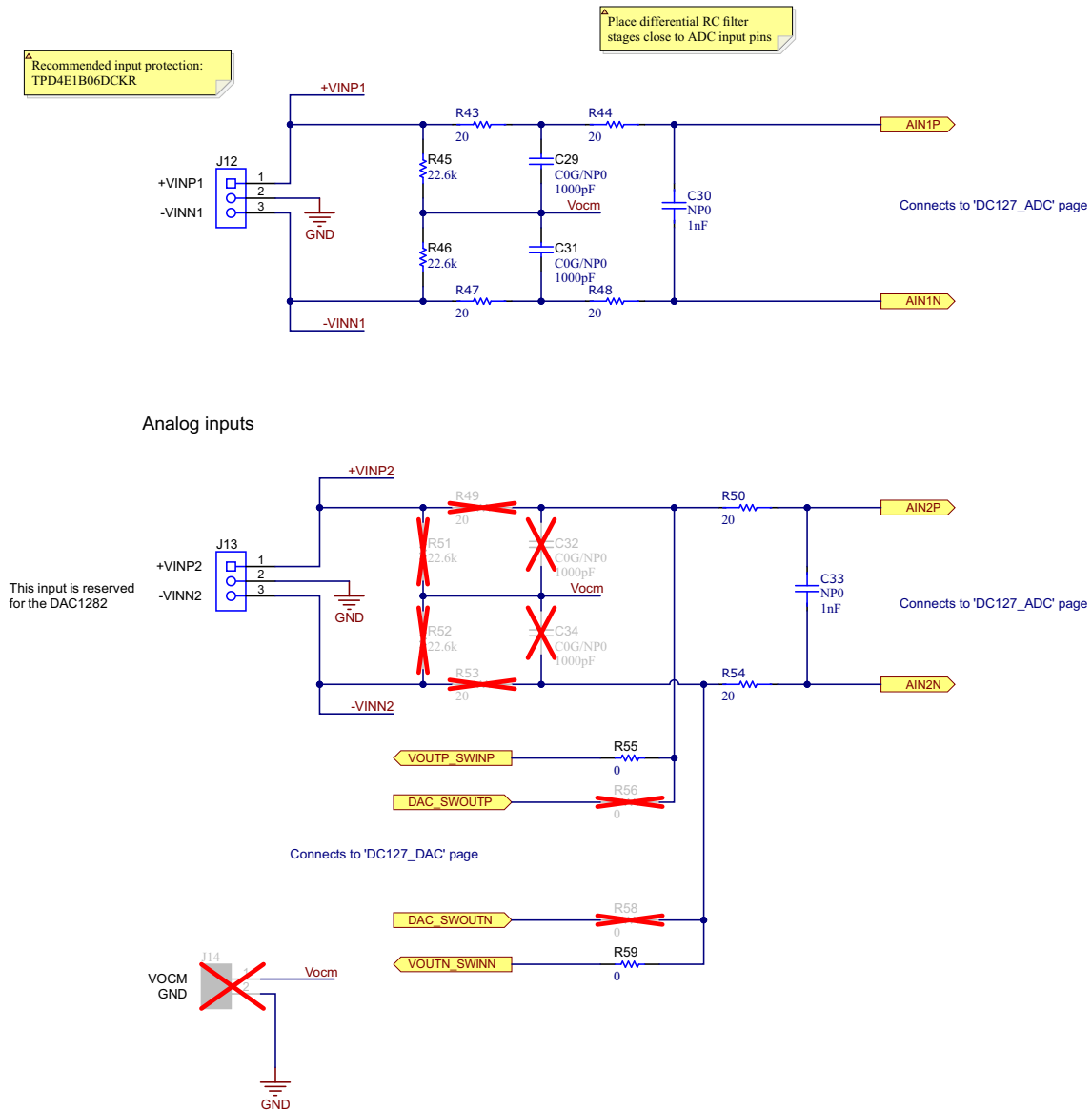


Figure 3-1. Input Terminal Blocks and Headers (Schematic)

Table 3-1. Analog Input Terminal Blocks (J12, J13)

Terminal Block	Pin	Function	ADS1285 Input Pin(s)
J12	1	Channel 1 positive input	+VINP1 (Eventually leading to AIN1P)
	2	GND	AGND and DGND
	3	Channel 1 negative input	-VINN1 (Eventually leading to AIN1N)
J13	1	Channel 2 positive input	+VINP2 (Eventually leading to AIN2P)
	2	GND	AGND and DGND
	3	Channel 2 negative input	-VINN2 (Eventually leading to AIN2N)

3.2 ADC Input Clock (CLK) Options

Using the onboard oscillator, clock dividers, and external connectors, the ADS1285EVM-PDK has device configuration flexibility. The ADC operates from CLK, which generates the modulator clock (f_{MOD}), provided in one of two ways:

- A crystal oscillator and the accompanying clock dividers can provide a selectable frequency for the entire range of the ADC.
 - The onboard crystal oscillator (Y1) provides the nominal 8.192-MHz clock frequency (default)
 - The dividers (U6) step down the frequency to 4.096 MHz
 - J8 allows the user to select between these frequencies and connect them directly to CLK by using a shunt
- An external main clock can be provided to a subminiature version A (SMA) connector (J5) or to pins 4 or 2 of J7 when a shunt does not select the frequency from the crystal oscillator.
 - In this case, a shunt must not cover J7 so that CLK is connected to any of the crystal oscillator signals
 - Be sure to review the valid CLKIN input frequency in the data sheet

Note

All clock sources are sourced back to the PHI connector (J6) so that the GUI SCLK communication is synchronous with CLK.

Figure 3-2 shows a schematic for the clock source.

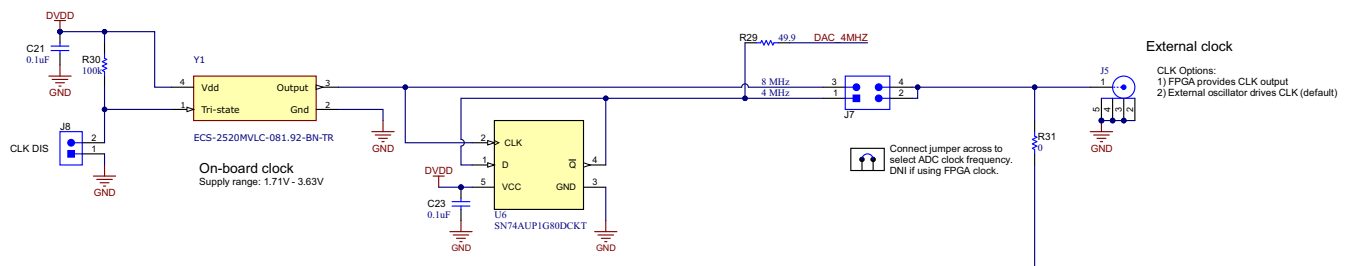


Figure 3-2. CLK Source (Schematic)

4 Digital Interface

As noted in [Section 1](#), the EVM interfaces with the PHI and communicates with the computer over the USB. There are two devices on the EVM with which the PHI communicates: the ADS1285 ADC (over SPI) and the EEPROM (over I²C). The EEPROM comes pre-programmed with the information required to configure and initialize the ADS1285EVM-PDK GUI. When the hardware is initialized, the EEPROM is no longer used.

4.1 Connection to the PHI

The ADS1285EVM-PDK board communicates with the PHI through a shrouded, 60-pin connector, J6. There are two round standoffs next to J6 with Phillips-head screws. To connect the PHI to the EVM, remove the screws, attach the PHI to the EVM, and replace the screws into the standoffs. The screws secure the EVM to the PHI and ensures the connection between the boards.

[Table 4-1](#) lists the different PHI connection and their functions.

Table 4-1. PHI Connector Pin Functions

PHI Connector Pin Name	PHI Connector Pin	Function
5.5V	J6[1]	Power-supply source for the analog section of the EVM
GND	J6[3]	Ground
~RESET	J6[6]	ADC reset pin, active low
~PWDN	J6[8]	ADC power-down pin, active low
SYNC	J6[12]	ADC synchronization, active high
DIN_PHI	J6[12]	SPI: DIN from the ADC, POCI, or serial interface data in (pre-RTM GUI revision compatibility)
GPIO1	J6[14]	General-purpose I/O 1 pin from the ADC
GPIO0	J6[16]	General-purpose I/O 0 pin from the ADC
DIN_PHI	J6[18]	SPI: DIN from the ADC, POCI, or serial interface data in (RTM GUI revision compatibility)
~CS_ADC	J6[22]	SPI: \overline{CS} , chip-select, or serial interface select, active low for the ADC
SCLK_PHI	J6[24]	SPI: Serial interface clock, or SCLK
CAPCLK_OUT	J6[26]	Output path for the PHI signal to synchronize captures with any delay from the EVM
CAPCLK_IN	J6[28]	Input path for the PHI signal to synchronize captures with any delay from the EVM
~DRDY	J6[30]	SPI: Data-ready signal for the ADS1285; active-low \overline{DRDY}
ADC_CLK (input)	J6[32]	Input for the PHI to sense CLK
ADC_CLK (output)	J6[34]	Possible output for the PHI to provide CLK (not supported on the ADS1285EVM-PDK)
DOUT	J6[38]	SPI: Serial data output for the ADS1285, or PICO
~RST/PWDN_DAC	J6[46]	Reset or power-down input pin for the DAC1282
SYNC_DAC	J6[48]	Synchronize input pin for the DAC1282
WP	J6[49]	Write protection for the EEPROM
DVDD	J6[50]	Power-supply source for the digital section of the EVM
SW/TD_DAC	J6[52]	Switch control input or bitstream input pin for the DAC1282
~CS_DAC	J6[54]	SPI: Serial port chip select, or \overline{CS} , for the DAC1282
SDA	J6[56]	I ² C serial data for the EEPROM used to identify the EVM
SCL	J6[58]	I ² C serial clock for the EEPROM used to identify the EVM
ID_PWR	J6[59]	Power-supply source for the EEPROM used to identify the EVM
GND	J6[60]	Ground

4.2 Digital Header

In addition to the PHI, the EVM has a header connected to the digital lines that can be used to connect a logic analyzer or oscilloscope. This placement allows for easy access to the digital communications. Header J9 is connected to the digital lines between the ADS1285 and the PHI connector. [Table 4-2](#) describes the digital header pins.

Table 4-2. Digital Header Pins

Signal Name	Digital Header Pin
~RESET	J9[1]
~PWDN	J9[3]
SYNC	J9[5]
DIN_PHI	J9[7]
GPIO1	J9[9]
GPIO0	J9[11]
~CS_ADC	J9[13]
SCLK_PHI	J9[15]
~DRDY	J9[17]
ADC_CLK	J9[19]
DOUT	J9[21]
~RST/PWDN_DAC	J9[23]
SYNC_DAC	J9[25]
SW/TD_DAC	J9[27]
~CS_DAC	J9[29]

5 Power Supplies

The PHI provides multiple power-supply options for the EVM, derived from the USB supply of the computer that is routed to the 5.5-V net on the ADS1285EVM-PDK on the board.

The EEPROM on the ADS1285EVM-PDK uses a 3.3-V power supply, ID_PWR, generated directly by the PHI. The 3.3-V supply to the digital section of the ADC (3V3_IOVDD) is provided directly by a separate LDO on the PHI.

[Figure 5-1](#) and [Table 5-1](#) describe the supply generation and programmable configurations, respectively.

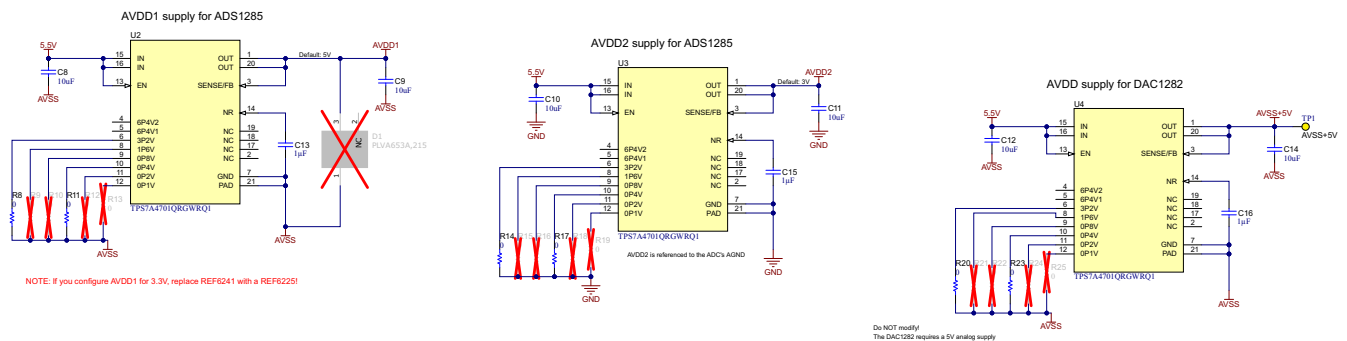


Figure 5-1. ADS1285EVM-PDK AVDD1, AVDD2, and AVSS+5V Supply Generation (Schematic)

Table 5-1. Programmable LDO Configurations

V _{OUT} (V) ⁽²⁾	3P2V	1P6V	0P8V	0P4V	0P2V	0P1V
2.5	—	—	Installed ⁽¹⁾	—	Installed	Installed
3.0	—	Installed	—	—	—	—
3.3	—	Installed	—	—	Installed	Installed
4.5	—	Installed	Installed	Installed	Installed	Installed
5.0	Installed	—	—	Installed	—	—

(1) Installed = Solder a 0-Ω jumper to GND/AVSS.

(2) V_{OUT} = 1.4 V + Σ (all grounded pins).

The PGA positive analog supply of the ADC, AVDD1, is powered by the TPS7A4701 or TPS7A4700 (U2) onboard the EVM, which is a low-noise linear regulator that uses the 5.5-V supply on the PHI to generate a cleaner 5-V output. The TPS7A470x is a configurable LDO so R8 to R13 can be used to change the voltage.

AVDD2 is the modulator analog supply that is also used by the ADC. As with AVDD1, AVDD2 is generated by the TPS7A470x (U3) onboard the EVM, which is a low-noise linear regulator that uses the 5.5-V supply on the PHI to generate a cleaner 5-V output. The TPS7A470x is a configurable LDO so R14 to R19 can be used to change the voltage but a lower AVDD2 will result in lower THD performance in unipolar mode.

AVSS+5V is used for the analog supply of the DAC1282. This pin also uses a TPS7A470x (U4) onboard the EVM, which is a low-noise linear regulator that uses the 5.5-V supply on the PHI to generate a cleaner 5-V output. The DAC1282 requires a 5-V supply so R20 to R25 must not be modified.

The user has the option to configure the EVM for unipolar supplies (AVSS = 0 V) by placing a jumper to cover pins 1 and 2 of J4 (UNIPOL), or to configure the EVM for bidirectional supplies (AVSS = -2.5 V) by placing the jumper to cover pins 2 and 3 of J4 (BIPOL). The TPS7A3001 (U5) is an LDO with a V_{IN} range from -3 V to -36 V that provides a clean -2.5-V output for the AVSS voltage. However, an external voltage is needed to supply the AVSS voltage, which can be supplied using J3. Because AVDD1 is referenced to AVSS, the output AVDD1 must be modified using R8 to R13 so that the AVDD1 to AVSS voltage does not go above the recommended operating conditions. Figure 5-2 shows the supply selection and -2.5-V generation circuit.

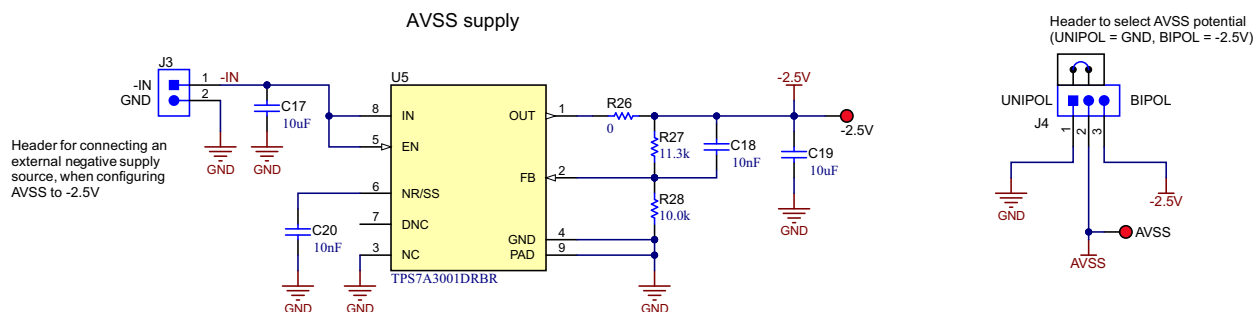


Figure 5-2. ADS1285EVM-PDK Unipolar and Bidirectional Supplies Selection (Schematic)

AVDD1 is used as the supply for the REF6241, which is a high-precision voltage reference with an integrated high-bandwidth buffer in reference to AVSS. The voltage reference can be used to supply the positive reference, VREFP, for the ADC and DAC using R38 as a pass transistor. Alternatively, R38 and R42 can be depopulated so the positive and negative reference externally using pins 1 and 2 of J10, respectively.

Figure 5-3 shows a schematic of the voltage reference.

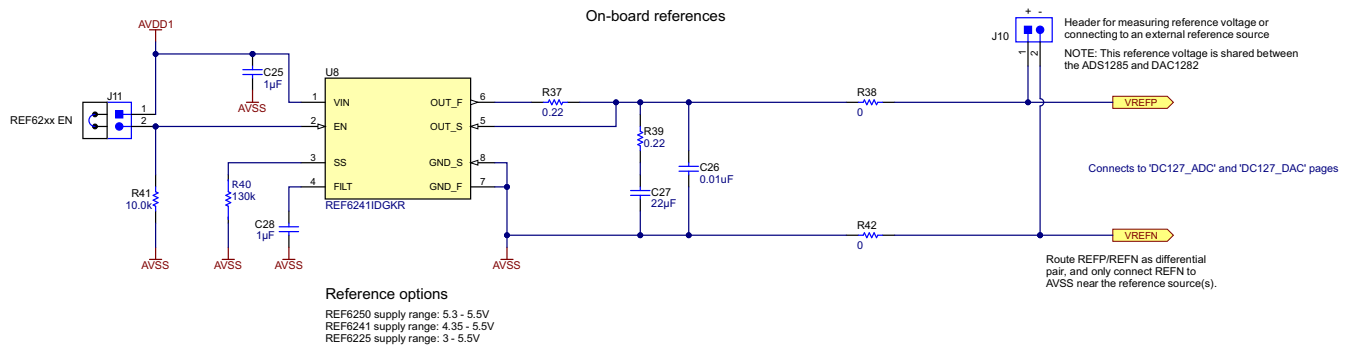


Figure 5-3. Voltage Reference (Schematic)

The power supply for each active component on the EVM is bypassed with a ceramic capacitor placed close to that component. Additionally, the EVM layout uses thick traces or large copper fill areas, where possible, between bypass capacitors and their loads to minimize inductance along the load current path.

As mentioned previously in [Section 1](#), power to the EVM is supplied by the PHI through connector J5. For information about PHI pins and the power connections, see [Table 4-1](#).

With modifications, the user can use external supplies for any voltage supplies. Using the ADC PWR header (J26), DAC PWR header (J1), and the unipolar or bipolar select (J4); the shunts can be depopulated for direct access to the AVDD1, AVDD2, AVSS+5V, DVDD, and AVSS pins.

6 Digital-to-Analog Converter

The ADS1282EVM-PDK contains a DAC1282, which is a fully integrated digital-to-analog converter (DAC) that provides a low-distortion, digital-synthesized voltage output designed for testing seismic equipment and the ADS128x family of devices; see the [DAC1282 data sheet](#) for more information. The DAC1282 can be used in combination with the GUI to directly supply an input voltage for testing and performance purposes. For more information on configuring the inputs to use the DAC1282, see [Section 3.1](#).

If using the DAC in Sine mode, the output frequency is programmable from 0.5 Hz to 250 Hz and the magnitude is scaled by both analog and digital control. The analog gain is adjustable in 6-dB steps and the digital gain in 0.5-dB steps. The analog gain settings match those of the ADS1282 for testing at all gains with high resolution. Controlling the settings of the DAC1282 can be done on the *DAC Configuration* page of the GUI as explained in [Section 8.6](#).

The DAC1282 uses AVSS+5V and DVDD for the power supplies and shares the same reference as the ADS1285. This configuration minimizes potential errors from using separate references between the devices. However, most of the DAC1282 documentation is in reference to a 5-V supply where the ADS1285EVM-PDK uses a 4.096-V reference by default. As a result, the DAC output amplitude is scaled in reference to the 4.096-V reference through the following equation:

$$V_{out_peak} = V_{FSR_peak} \cdot 10^{\frac{G_{DAC_Dig}(dB)}{20}} \quad (1)$$

where:

- V_{out_peak} = Output amplitude of the DAC in Sine mode
- V_{FSR_peak} = Positive peak of the full-scale range calculation, which depends on voltage reference
- $G_{DAC_Dig}(dB)$ = Digital gain of the DAC determined by the SINEG register

This equation and scaling is automatically calculated in the ADS1285EVM-PDK GUI; see [Section 8.6](#).

7 ADS1285EVM-PDK Initial Setup

This section explains the initial hardware and software setup procedure that must be completed for properly operating the ADS1285EVM-PDK.

7.1 Default Jumper Settings

After unpacking, the EVM is already configured with the default jumper settings. Figure 7-1 shows the locations for the default jumpers and Table 7-1 shows the functions of the default shunts.

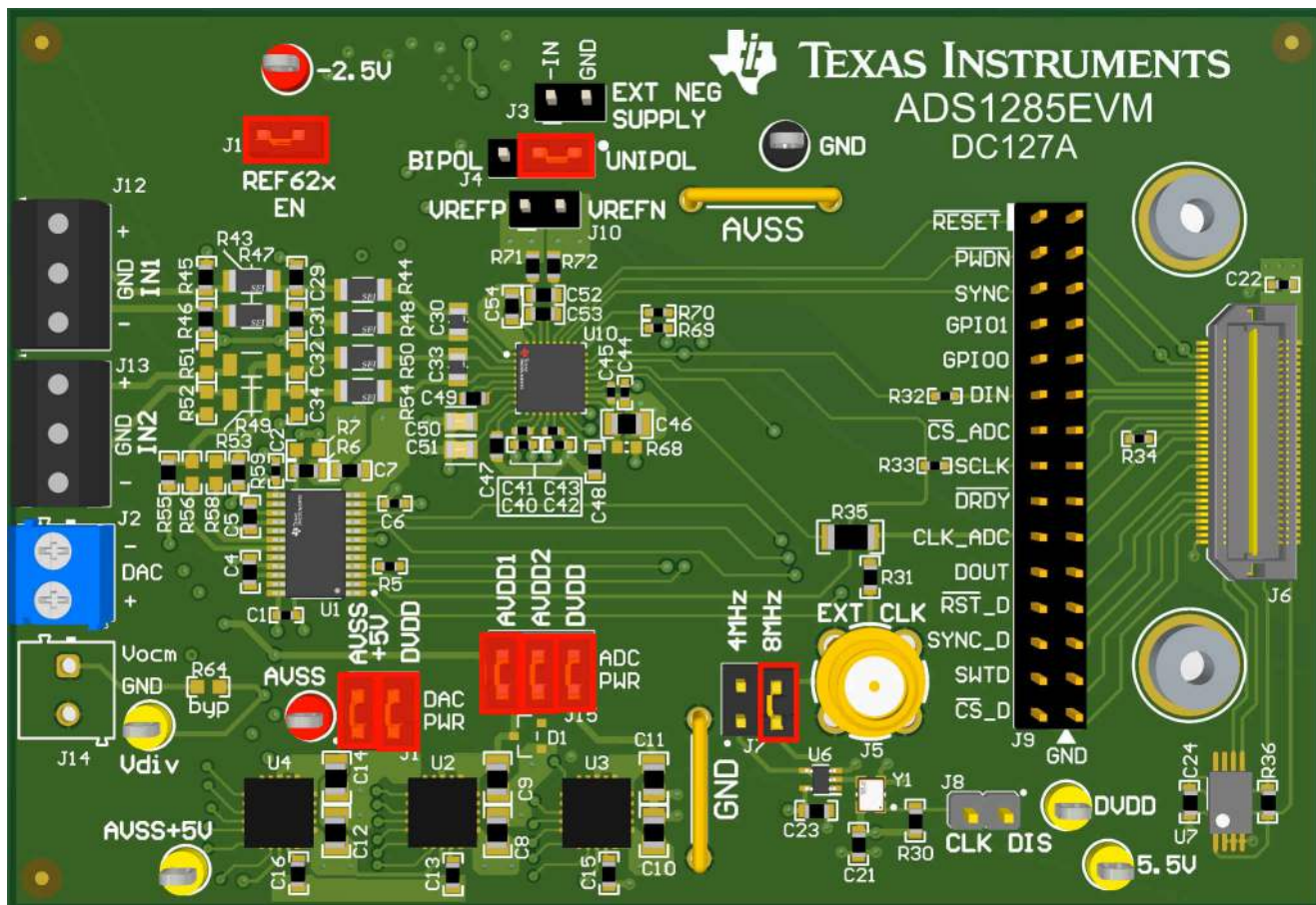


Figure 7-1. ADS1285EVM-PDK Jumper Default Settings

Table 7-1. Default Shunt Settings

Header Designator	Position	Function
J11	[1-2]	Enables the REF62x supply to VREFP
J4	[1-2]	Connects AVSS to GND for unipolar ADC supply mode
J7	[3-4]	Connects CLK to an 8.192-MHz source from the crystal oscillator
J10	Not installed	Header to supply the external reference voltage to VREFN and VREFP
J1	[1-2]	DAC PWR: Connects the output of the U4 LDO (AVSS+5V) to the DAC analog supply pin (AVDD)
J1	[3-4]	DAC PWR: Connects the PHI digital supply (DVDD) to the DAC digital supply pin (DVDD)
J15	[1-2]	ADC PWR: Connects the output of the U2 LDO (AVDD1) to the ADC analog supply 1 (AVDD1)
J15	[3-4]	ADC PWR: Connects the output of the U3 LDO (AVDD2) to the ADC analog supply 2 (AVDD2)
J15	[5-6]	ADC PWR: Connects the PHI digital supply (DVDD) to the ADC digital supply (IOVDD)
J3	Not installed	Header to supply the external input to U5 for the -2.5-V supply
J8	Not Installed	Enables 8.192-MHz crystal oscillator

Table 7-2 lists the nominal voltages that result from the default configuration.

Table 7-2. Nominal Voltages Resulting From a Default Configuration

Supply Name	Voltage (Referenced to GND)
AVSS	GND (0 V)
AVSS+5V	5 V
DVDD (IOVDD)	3.3 V
AVDD1	5 V
AVDD2	5 V
5.5V	5.5 V
REFP	4.096 V
-2.5V	NA, external supply needed to generate -2.5 V

7.2 EVM Graphical User Interface (GUI) Software Installation

Download the latest version of the EVM GUI installer from the *Tools and Software* folder of the ADS1285EVM-PDK and run the GUI installer to install the EVM GUI software on your computer.

CAUTION

Manually disable any antivirus software running on the computer before downloading the EVM GUI installer onto the local hard disk. Depending on the antivirus settings, an error message may appear or the installer. The .exe file can be deleted.

Accept the license agreements and follow the on-screen instructions shown in Figure 7-2 to complete the installation.

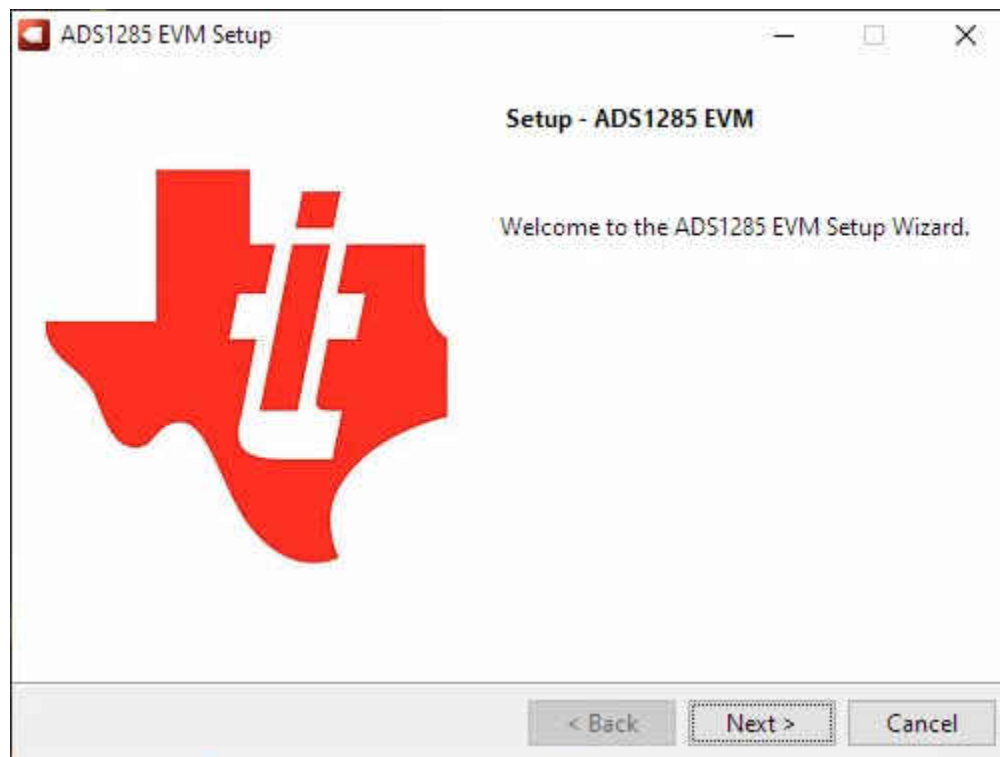


Figure 7-2. ADS1285 Software Installation Prompt

As part of the ADS1285EVM-PDK GUI installation, a prompt with a device driver installation (as shown in [Figure 7-3](#)) appears on the screen. Click *Next* to proceed.

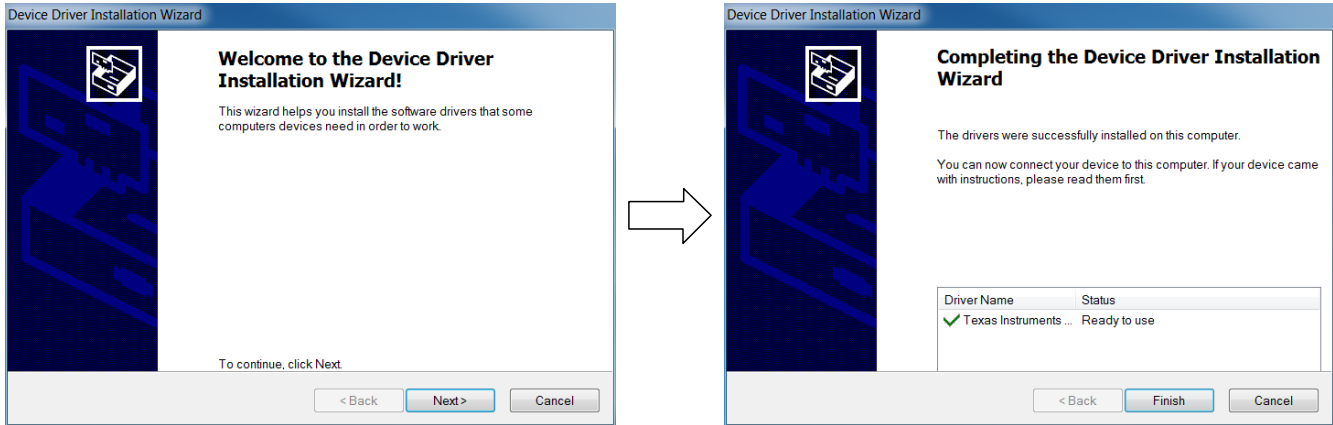


Figure 7-3. Device Driver Installation Wizard Prompts

Note

A notice may appear on the screen stating that Windows cannot verify the publisher of this driver software. Select *Install this driver software anyway*.

The ADS1285EVM-PDK requires the LabVIEW® run-time engine and may prompt for the installation of this software, as shown in [Figure 7-4](#), if not already installed.

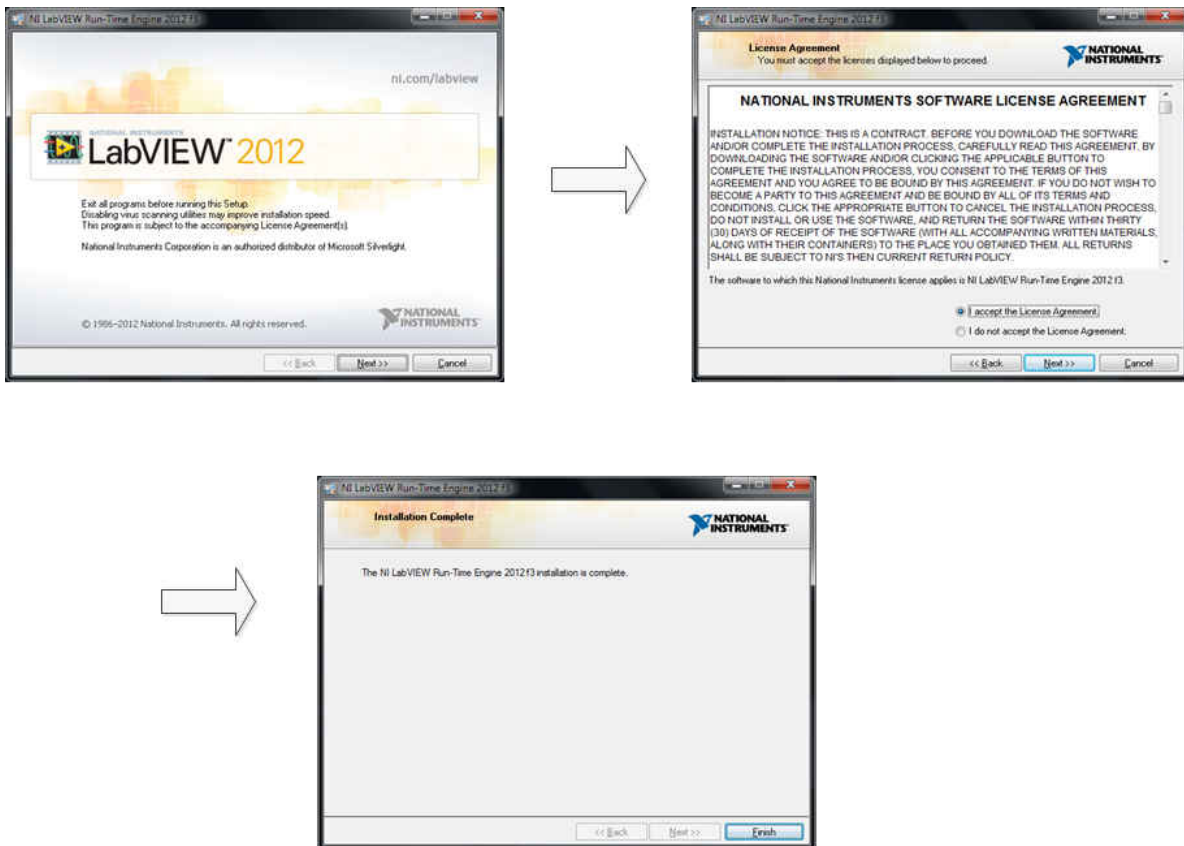


Figure 7-4. LabVIEW Run-Time Engine Installation

Verify that *C:\Program Files (x86)\Texas Instruments\ADS1285EVM-PDK* is available after these installations.

8 ADS1285EVM-PDK Software Reference

8.1 EVM GUI Global Settings for ADC Control

Although the EVM GUI does not allow direct access to the levels and timing configuration of the ADC digital interface, the EVM GUI does give users high-level control over many other functions of the ADS1285, including: internal clock dividers, oversampling ratio (OSR), and number of samples to be captured. [Figure 8-1](#) identifies the input parameters of the GUI (as well as their default values) through which the various functions of the ADS1285 can be exercised.

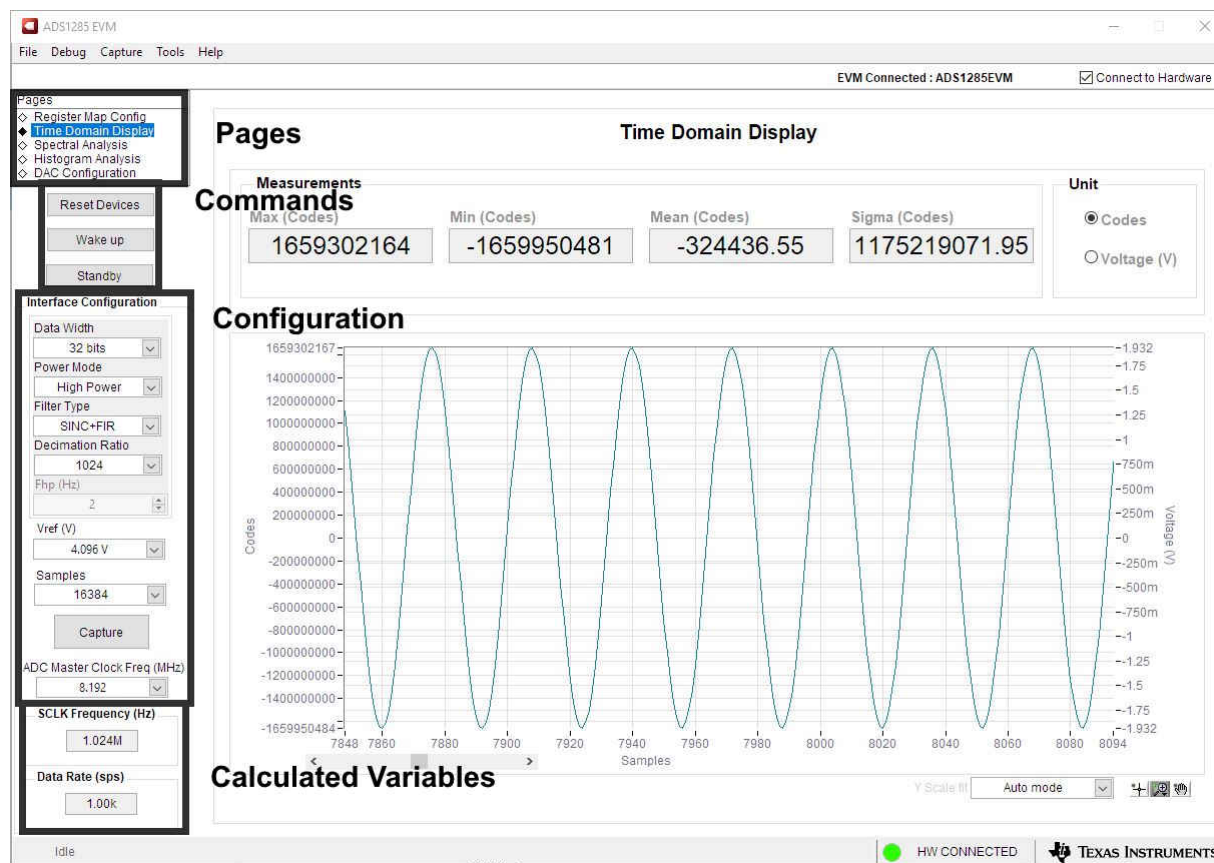


Figure 8-1. EVM GUI Global Input Parameters

There are four pages available in the ADS1285EVM-PDK GUI. The information area displays the results of each of the pages. Each of these pages display a different control or measurement of the device. The *Register Map Config* page reads and writes the registers of the device. The *Time Domain Display* page collects a set of data from the device and displays the result. The *Spectral Analysis* page can compute the FFT of the collected data, and the *Histogram Analysis* page shows a histogram of the collected data and displays basic statistics of the result.

The *Single Commands* section allows for direct control of the device for three basic functions. First, the **Reset** button sends a signal to the RESET pin to reset the device. The **Standby** button puts the device into a low-power state where all channels are disabled, and the reference and other non-essential circuitry are powered down. The **Wakeup** button exits standby mode.

The *Interface Configuration* section also sets the data rate by setting the internal clock dividers and OSR in the ADC. Finally, this section can set the power modes in the registers. The ADS1285 has three power modes (low-power, mid-power, and high-power) that are configured in the CONFIG0 register (bits 7-6). This configuration is used in conjunction with the jumper settings of JP8 for the CLK pin, as outlined in [Section 3.2](#).

The *Clock and Sampling Rate* section allows the user to specify a target SCLK frequency (in Hz) and the GUI tries to match this frequency as closely as possible by changing the PHI PLL settings, but the achievable

frequency may differ from the target value entered. This section also displays the sampling rate of the ADC as controlled by the internal clock dividers and the OSR.

The GUI is switched between hardware mode and simulation mode by checking and unchecking the *Connected to Hardware* box in the top right area of the screen at any time.

8.2 Register Map Configuration Tool

The register map configuration tool allows the user to view and modify the registers of the ADS1285. This tool can be selected, as indicated in Figure 8-2, by clicking on the **Register Map Config** radio button at the *Pages* section of the left pane. On power-up, the values on this page correspond to the *Host Configuration Settings* that enable ADC sampling at the maximum sampling rate specified for the ADC. The register values can be edited by double-clicking the corresponding value field. If interface mode settings are affected by the change in register values, this change reflects on the left pane immediately.

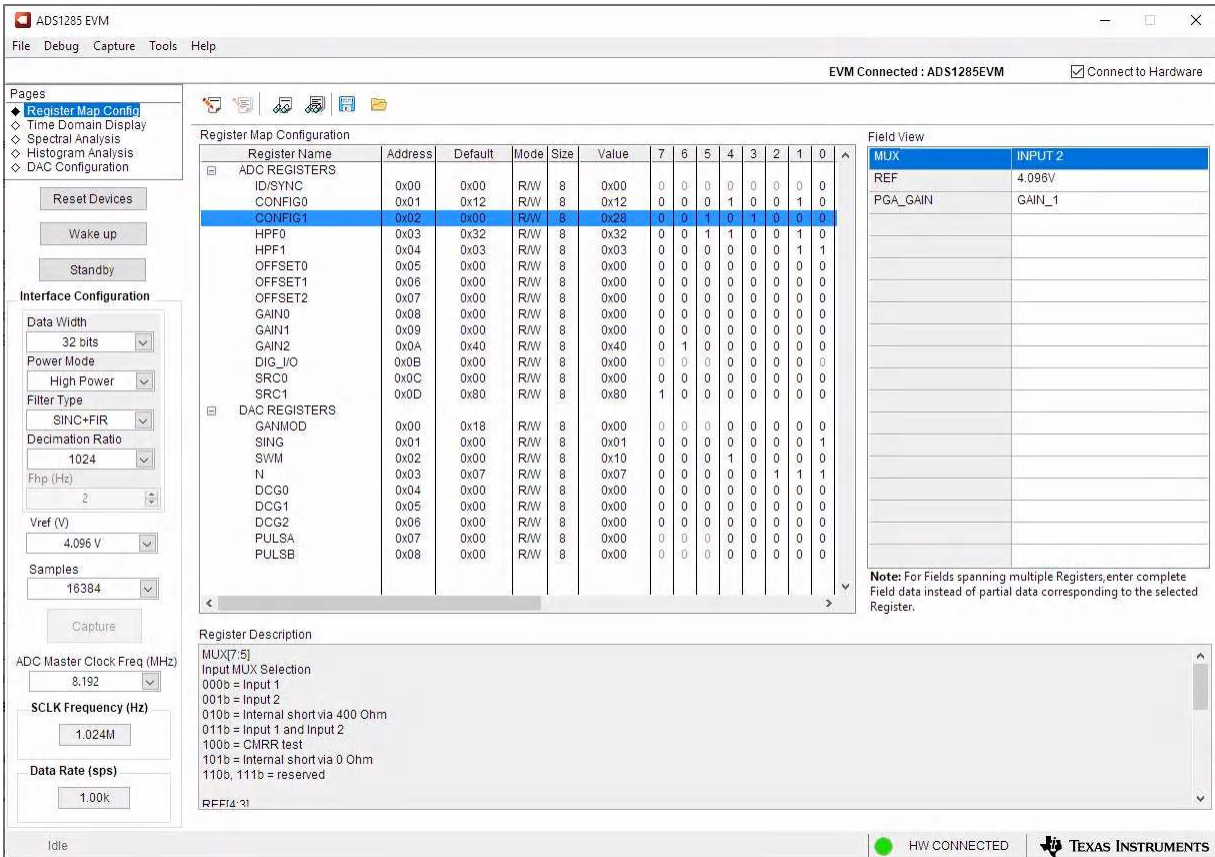


Figure 8-2. Register Map Configuration

Section 8.3 through Section 8.5 describe the data collection and analysis features of the ADS1285EVM-PDK GUI.

8.3 Time Domain Display Tool

The time domain display tool allows visualization of the ADC response to a given input signal. This tool is useful for both studying the behavior and debugging any gross problems with the ADC or drive circuits.

The user can trigger a capture of the data of the selected number of samples from the ADS1285EVM-PDK, as per the current interface mode settings indicated in [Figure 8-3](#) by using the **Capture** button. The sample indices are on the x-axis and there are two y-axes showing the corresponding output codes as well as the equivalent analog voltages based on the specified reference voltage. Switching pages to any of the *Analysis* tools described in the subsequent sections causes calculations to be performed on the same set of data.

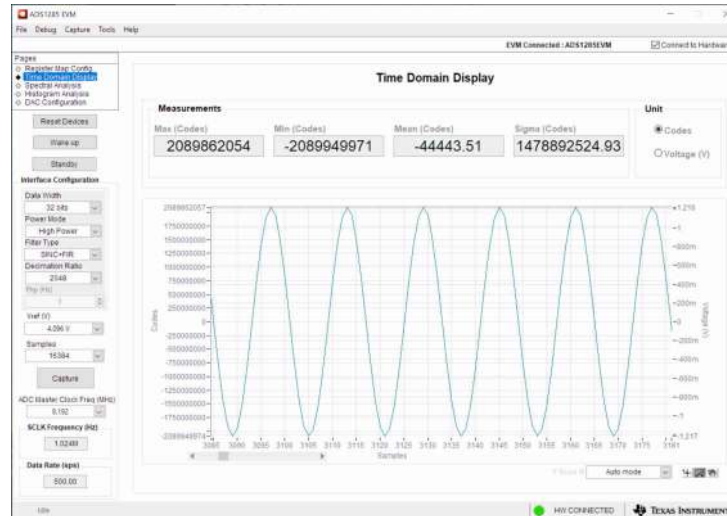


Figure 8-3. Time Domain Display Tool Options

8.4 Spectral Analysis Tool

The spectral analysis tool, shown in [Figure 8-4](#), is intended to evaluate the dynamic performance (SNR, THD, SFDR, SINAD, and ENOB) of the ADS1285 ADC through single-tone sinusoidal signal FFT analysis using the *7-term Blackman-Harris* window setting.



Figure 8-4. Spectral Analysis Tool

The FFT tool includes windowing options that are required to mitigate the effects of non-coherent sampling (this discussion is beyond the scope of this document). The *7-Term Blackman-Harris* window is the default option and has sufficient dynamic range to resolve the frequency components of up to a 24-bit ADC. The *None* option corresponds to not using a window (or using a rectangular window) and is not recommended.

8.5 Histogram Tool

Noise degrades ADC resolution and the histogram tool can be used to estimate effective resolution, which is an indicator of the number of bits of ADC resolution losses resulting from noise generated by the various sources connected to the ADC when measuring a DC signal. The cumulative effect of noise coupling to the ADC output from sources such as the input drive circuits, the reference drive circuit, the ADC power supply, and the ADC is reflected in the standard deviation of the ADC output code histogram that is obtained by performing multiple conversions of a DC input applied to a given channel.

As shown in [Figure 8-5](#), the histogram corresponding to a DC input is displayed on clicking the **Capture** button.

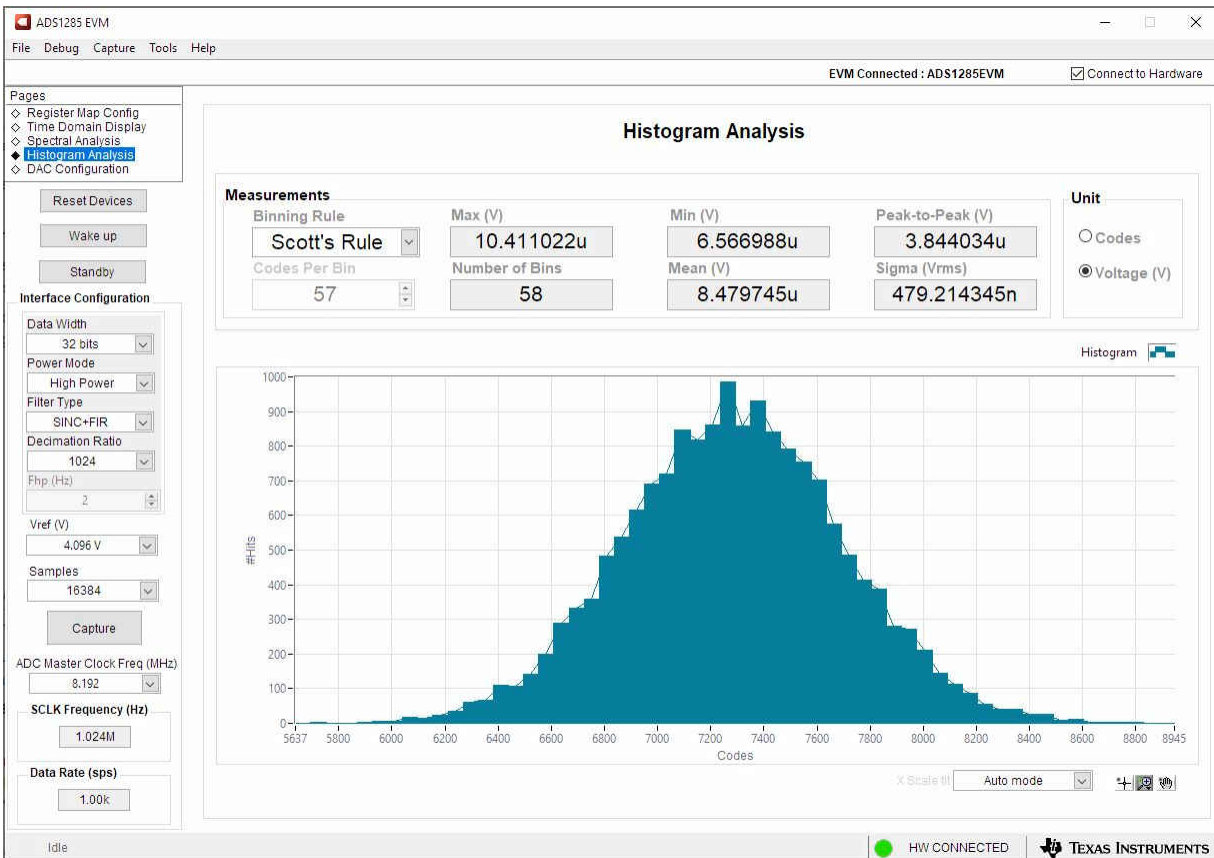


Figure 8-5. Histogram Analysis Tool

8.6 DAC Configuration Tool

The DAC configuration tool page ([Figure 8-6](#)) controls the onboard DAC1282, a test DAC specifically designed to work with the ADS128x family of devices. As previously discussed in [Section 6](#), the DAC output frequency is programmable from 0.5 Hz to 250 Hz and the magnitude is scaled by both analog and digital control. The analog gain is adjustable in 6-dB steps and the digital gain in 0.5-dB steps. The analog gain settings match those of the ADS1282 for testing at all gains with high resolution. More information about each setting can be found in the DAC1282 data sheet.

In general, the most important outcomes of changing the DAC are to understand the mode, output amplitude, and output frequency (if applicable). In the middle, the *Operation* box shows the Mode drop-down, which can be: Sine, DC, digital pulse, and pulse.

For Sine, the amplitude is determined by a combination of the analog gain and digital gain settings. In addition, the DAC page uses the Vref (V) drop-down menu to calculate the values in the gray boxes, although the DAC does not need to know the reference voltage to function. As a result, review the Sine AMP (Vp) calculation, in combination with the ADC gain on the register map page, to understand the output code and voltage of the ADC. The frequency is determined by typing a desired frequency into the *Desired Frequency (Hz)* text box. The GUI automatically displays the closest Freq, M, and N values to achieve the desired output frequency that are

eventually written into the DAC registers. These options dynamically change when selecting DC, digital pulse, or pulse.

As mentioned in Section 3.1, the direct DAC output or the DAC integrated switches can be used. Assuming the correct hardware is changed to support the integrated switches, the state of the switches can be changed using the Switch Control drop-down.

The settings in Figure 8-6, in combination with selecting 2 V/V for PGA_GAIN and Input 2 for MUX, create the time domain and spectral analysis plots in Figure 8-3 and Figure 8-4, respectively.

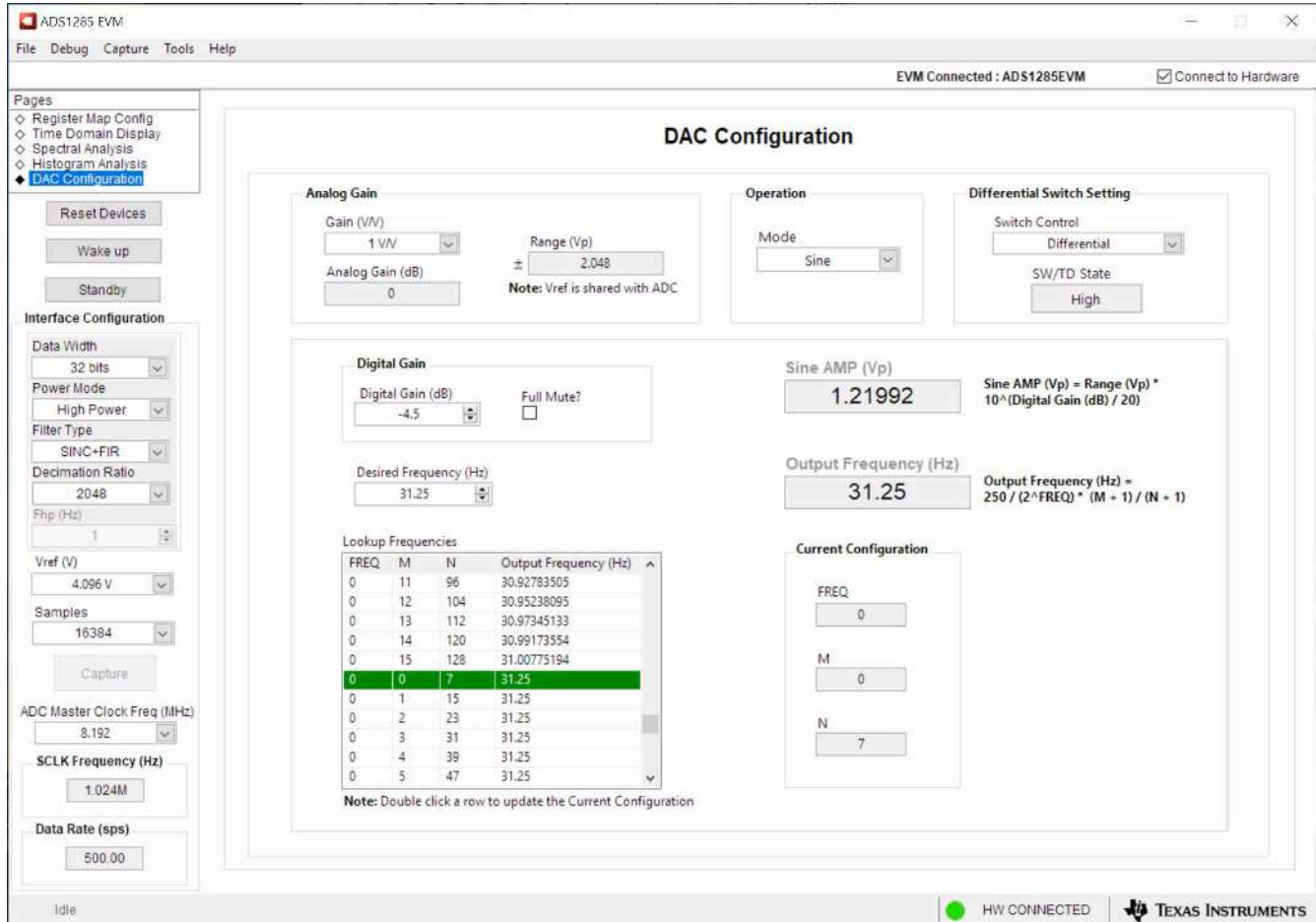


Figure 8-6. DAC Configuration Tool Page

9 ADS1285EVM-PDK Bill of Materials, PCB Layout, and Schematics

9.1 Bill of Materials

Table 9-1 lists the ADS1285EVM-PDK bill of materials (BOM).

Table 9-1. ADS1285EVM-PDK BOM

Designator	Quantity	Value	Description	Package Reference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
!PCB1	1		Printed Circuit Board		DC127	Any		
C1, C2, C3, C6, C22, C40, C42, C44, C55	9	1uF	CAP, CERM, 1 uF, 35 V, +/- 10%, X5R, 0402	402	C1005X5R1V105K050BC	TDK		
C4, C5, C26	3	0.01uF	CAP, CERM, 0.01 uF, 25 V, +/- 5%, C0G/NP0, AEC-Q200 Grade 1, 0603	603	C0603C103J3GEC AUTO	Kemet		
C7, C48, C53, C54	4	0.1uF	CAP, CERM, 0.1 uF, 50 V, +/- 10%, X5R, 0603	603	C1608X5R1H104K080AA	TDK		
C8, C9, C10, C11, C12, C14, C17, C19	8	10uF	CAP, CERM, 10 uF, 25 V, +/- 10%, X5R, 0805	805	CL21A106KAFN3NE	Samsung Electro-Mechanics		
C13, C15, C16, C25, C28, C39	6	1uF	CAP, CERM, 1 uF, 25 V, +/- 10%, X7R, 0603	603	C0603C105K3RAC TU	Kemet		
C18, C20	2	0.01uF	CAP, CERM, 0.01 uF, 50 V, +/- 10%, X7R, 0603	603	8.85012E+11	Würth Elektronik		
C21, C23, C24, C36	4	0.1uF	CAP, CERM, 0.1 uF, 50 V, +/- 10%, X8R, AEC-Q200 Grade 0, 0603	603	CGA3E3X8R1H104K080AB	TDK		
C27	1	22uF	CAP, CERM, 22 uF, 16 V, +/- 20%, X5R, AEC-Q200 Grade 3, 1206	1206	CL31A226MOHNNNE	Samsung Electro-Mechanics		
C29, C31	2	1000pF	CAP, CERM, 1000 pF, 50 V, +/- 5%, C0G/NP0, 0603	603	C0603C102J5GAC TU	Kemet		
C30, C33	2	1nF	1000pF ±5% 50V Ceramic Capacitor C0G, NP0 0805 (2012 Metric)	805	CC0805JRNPO9BN102	Yageo		
C35, C37	2	33nF	Cap Ceramic 33nF 50V NP0 5% Pad SMD 0805 +150°C Automotive T/R	805	CGA4J2NP01H333J125AA	TDK Corporation		
C38	1	1uF	CAP, CERM, 1 uF, 50 V, +/- 10%, X7R, AEC-Q200 Grade 1, 1206	1206	CGA5L3X7R1H105K160AB	TDK		
C41, C43, C45	3	0.1uF	CAP, CERM, 0.1 uF, 25 V, +/- 10%, X7R, 0402	402	GRM155R71E104KE14D	MuRata		
C46	1	0.22uF	CAP, CERM, 0.22 uF, 50 V, +/- 10%, X7R, 0805	805	C0805C224K5RAC TU	Kemet		
C47	1	4700pF	CAP, CERM, 4700 pF, 50 V, +/- 10%, X7R, 0603	603	C0603X472K5RAC TU	Kemet		
C49	1	0.01uF	CAP, CERM, 0.01 uF, 50 V, +/- 5%, C0G/NP0, 0603	603	GRM1885C1H103JA01D	MuRata		

Table 9-1. ADS1285EVM-PDK BOM (continued)

Designator	Quantity	Value	Description	Package Reference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
C50, C51	2	47nF	0.047 μ F \pm 1% 25V Ceramic Capacitor C0G, NP0 0805 (2012 Metric)	805	C0805C473F3GAC 7800	KEMET		
C52	1	1 μ F	CAP, CERM, 1 μ F, 16 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0603	603	GCM188R71C105 KA64J	MuRata		
FID1, FID2, FID3	3		Fiducial mark. There is nothing to buy or mount.	N/A	N/A	N/A		
H1, H2	2		Machine Screw Pan PHILLIPS M3		RM3X4MM 2701	APM HEXSEAL		
H3, H4, H5, H6	4		Bumpon, Hemisphere, 0.44 X 0.20, Clear	Transparent Bumpon	SJ-5303 (CLEAR)	3M		
H7, H8	2		ROUND STANDOFF M3 STEEL 5MM	ROUND STANDOFF M3 STEEL 5MM	9774050360R	Würth Elektronik		
J1, J7	2		Header, 100mil, 2x2, Gold, TH	2x2 Header	TSW-102-07-G-D	Samtec		
J2	1		Terminal Block, 3.5mm, 2x1, Tin, TH	Terminal Block, 3.5mm, 2x1, TH	1776275-2	TE Connectivity		
J3, J10, J11	3		Header, 100mil, 2x1, Tin, TH	Header, 2 PIN, 100mil, Tin	PEC02SAAN	Sullins Connector Solutions		
J4	1		Header, 100mil, 3x1, Tin, TH	Header, 3 PIN, 100mil, Tin	PEC03SAAN	Sullins Connector Solutions		
J5	1		Connector, SMA, TH	SMA	142-0701-231	Cinch Connectivity		
J6	1		Header(Shrouded), 19.7mil, 30x2, Gold, SMT	Header (Shrouded), 19.7mil, 30x2, SMT	QTH-030-01-L-D-A- K-TR	Samtec		
J8	1		Header, 100mil, 2x1, Gold, TH	Sullins 100mil, 1x2, 230 mil above insulator	PBC02SAAN	Sullins Connector Solutions		
J9	1		Header, 100mil, 15x2, Gold, TH	15 x 2 Header	MTSW-115-22-G- D-315	Samtec		
J12, J13	2		Terminal Block, 3.5mm Pitch, 3x1, TH	10.5x8.2x6.5mm	ED555/3DS	On-Shore Technology		
J15	1		Header, 100mil, 3x2, Tin, TH	3x2 Header	PEC03DAAN	Sullins Connector Solutions		
R1, R2, R30, R65, R66, R67	6	100k	RES, 100 k, 1%, 0.1 W, 0603	603	RC0603FR-07100K L	Yageo		
R3, R4, R6, R8, R11, R14, R17, R20, R23, R26, R31, R38, R42, R55, R59, R71, R72	17	0	RES, 0, 5%, 0.1 W, 0603	603	RC0603JR-070RL	Yageo		
R5, R29, R32, R33, R34, R69, R70	7	49.9	RES, 49.9, 1%, 0.063 W, 0402	402	RC0402FR-0749R9 L	Yageo America		

Table 9-1. ADS1285EVM-PDK BOM (continued)

Designator	Quantity	Value	Description	Package Reference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
R27	1	11.3k	RES, 11.3 k, 1%, 0.1 W, 0603	603	RC0603FR-0711K3L	Yageo		
R28, R36, R41, R61	4	10.0k	RES, 10.0 k, 1%, 0.1 W, 0603	603	RC0603FR-0710KL	Yageo		
R35	1	49.9	RES, 49.9, 1%, 0.25 W, 1206	1206	RC1206FR-0749R9L	Yageo America		
R37, R39	2	0.22	RES, 0.22, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	603	ERJ-3RQFR22V	Panasonic		
R40	1	130k	130 kOhms ±5% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric) Moisture Resistant Thick Film	603	RC0603JR-07130KL	Yageo		
R43, R44, R47, R48, R50, R54	6	20	Res Thick Film 1206 20 Ohm 1% 0.25W ±100ppm/°C Molded SMD Paper T/R	1206	RMCF1206FT20R0	Stackpole		
R45, R46	2	22.6k	RES, 22.6 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	603	CRCW060322K6FKEA	Vishay-Dale		
R57	1	1.00k	RES, 1.00 k, 1%, 0.1 W, 0603	603	RC0603FR-071KL	Yageo		
R60, R63	2	1.00Meg	RES, 1.00 M, 1%, 0.1 W, 0603	603	RC0603FR-071ML	Yageo		
R62	1	37.4	RES, 37.4, 1%, 0.1 W, 0603	603	RC0603FR-0737R4L	Yageo		
SH-J1, SH-J2, SH-J3, SH-J4, SH-J5, SH-J6, SH-J7, SH-J8	8	1x2	Shunt, 100mil, Gold plated, Black	Shunt	SNT-100-BK-G	Samtec	969102-0000-DA	3M
TP1, TP7, TP8, TP9	4		Test Point, Multipurpose, Yellow, TH	Yellow Multipurpose Testpoint	5014	Keystone Electronics		
TP2, TP6	2		Test Point, Multipurpose, Red, TH	Red Multipurpose Testpoint	5010	Keystone Electronics		
TP3	1		Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint	5011	Keystone Electronics		
TP4, TP5	2		1mm Uninsulated Shorting Plug, 10.16mm spacing, TH	Shorting Plug, 10.16mm spacing, TH	D3082-05	Harwin		
U1	1		Low Distortion Digital-to-Analog Converter for Seismic	TSSOP24	DAC1282IPWR	Texas Instruments		
U2, U3, U4	3		Automotive 35V, 1A, 4.2µVRMS, RF Low-Dropout (LDO) Voltage Regulator, RGW0020A (VQFN-20)	RGW0020A	TPS7A4701QRGW RQ1	Texas Instruments	TPS7A4701QRGW TQ1	Texas Instruments

Table 9-1. ADS1285EVM-PDK BOM (continued)

Designator	Quantity	Value	Description	Package Reference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
U5	1		Vin -3V to -36V, -200mA, Ultra-Low-Noise, High-PSRR, Low-Dropout (LDO) Linear Regulator, DRB0008A (VSON-8)	DRB0008A	TPS7A3001DRBR	Texas Instruments	TPS7A3001DRBT	Texas Instruments
U6	1		Low-Power Single Positive-Edge-Triggered D-Type Flip-Flop, DCK0005A, SMALL T&R	DCK0005A	SN74AUP1G80DC KT	Texas Instruments		
U7	1		I2C BUS EEPROM (2-Wire), TSSOP-B8	TSSOP-8	BR24G32FVT-3AG E2	Rohm		
U8	1		High-Precision Voltage Reference with Integrated High-Bandwidth Buffer, DGK0008A (VSSOP-8)	DGK0008A	REF6241IDGKR	Texas Instruments	REF6241IDGKT	Texas Instruments
U9	1		700 nA, Zero-Crossover Rail-to-Rail I/O Operational Amplifier, 1.8 to 5.5 V, -40 to 85 degC, 5-pin SOT23 (DCK5), Green (RoHS & no Sb/Br)	DCK0005A	OPA369AIDCKT	Texas Instruments		
U10	1		ADS1285 High Resolution, Delta-Sigma ADC for Seismic 4000sps 1 to 64 as Gain 3-5.25V	VQFN32	ADS1285IRHBT	Texas Instruments		None
Y1	1		8.192 MHz XO (Standard) CMOS Oscillator 1.6V ~ 3.6V Enable/Disable 4-SMD, No Lead	SMT4_2MM5_2MM 0	ECS-2520MVL-08 1.92-BN-TR	ECS		
C32, C34	0	1000pF	CAP, CERM, 1000 pF, 50 V, +/- 5%, C0G/NP0, 0603	603	C0603C102J5GAC TU	Kemet		
D1	0		Zener Diode Single 5V 4% 250Ohm 250mW Automotive 3-Pin SOT-23 T/R	SOT23	PLVA653A,215	Nexperia		
J14	0		Terminal Block, 3.5mm, 2x1, Tin, TH	Terminal Block, 3.5mm, 2x1, TH	1776275-2	TE Connectivity		
R7, R9, R10, R12, R13, R15, R16, R18, R19, R21, R22, R24, R25, R56, R58, R64, R68	0	0	RES, 0, 5%, 0.1 W, 0603	603	RC0603JR-070RL	Yageo		
R49, R53	0	20	Res Thick Film 1206 20 Ohm 1% 0.25W ±100ppm/°C Molded SMD Paper T/R	1206	RMCF1206FT20R0	Stackpole		

Table 9-1. ADS1285EVM-PDK BOM (continued)

Designator	Quantity	Value	Description	Package Reference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
R51, R52	0	22.6k	RES, 22.6 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	603	CRCW060322K6F KEA	Vishay-Dale		

9.2 PCB Layout

Figure 9-1 through Figure 9-6 show the ADS1285EVM-PDK PCB layout.

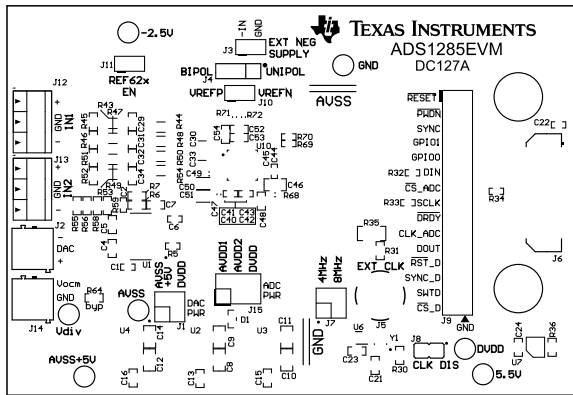


Figure 9-1. Top Silkscreen

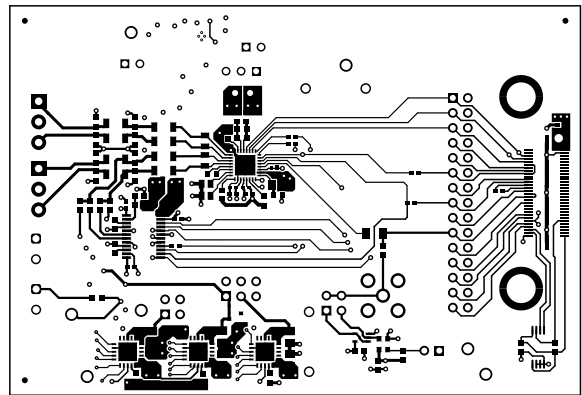


Figure 9-2. Top Layer

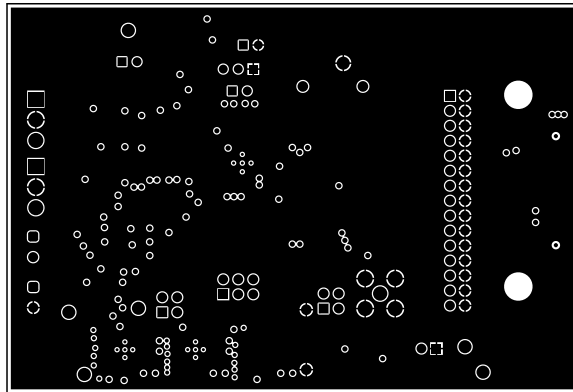


Figure 9-3. Ground Layer 1

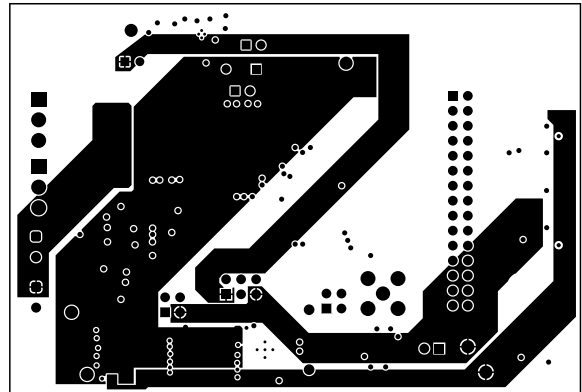


Figure 9-4. Power Layer

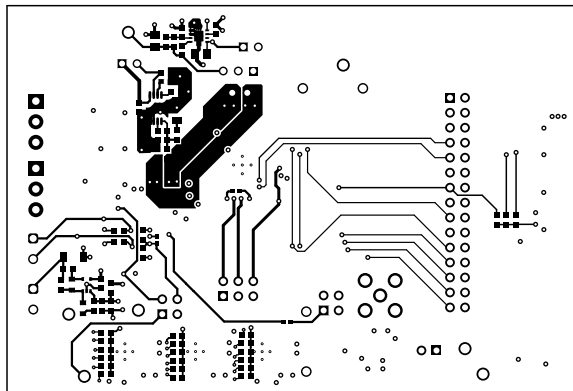


Figure 9-5. Bottom Layer

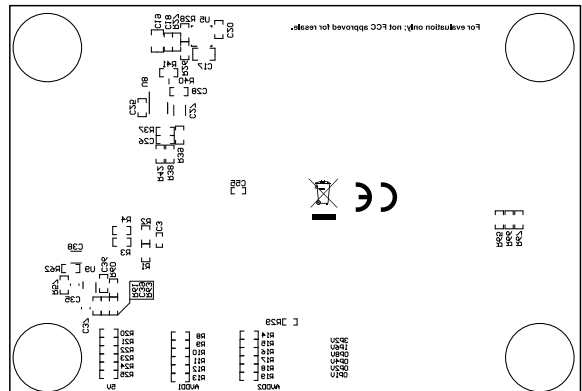


Figure 9-6. Bottom Silkscreen

9.3 Schematics

Figure 9-7 shows a block diagram of the ADS1285EVM-PDK.

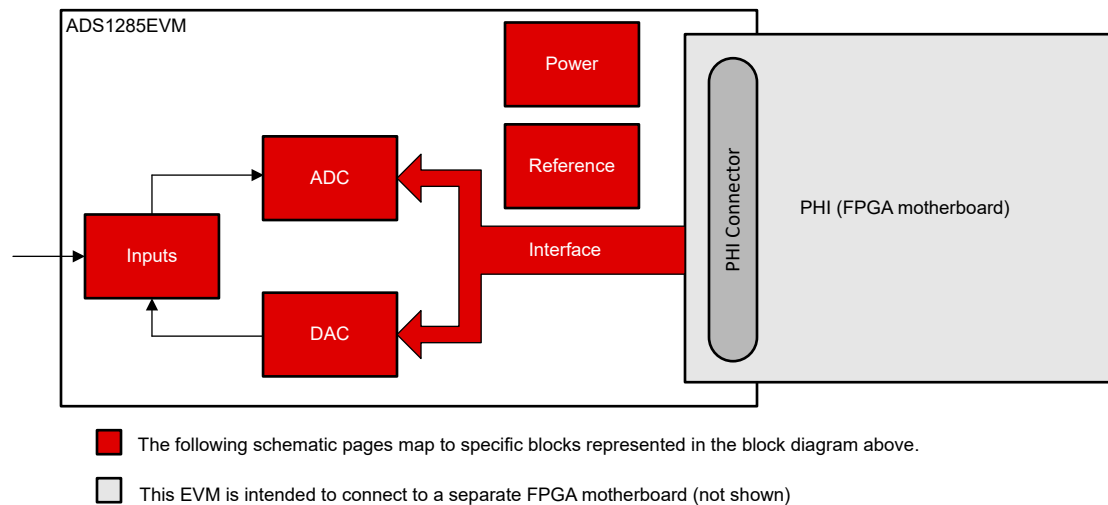


Figure 9-7. ADS1285EVM-PDK Block Diagram

Figure 9-8 through Figure 9-13 illustrate various schematics for the ADS1285EVM-PDK ADC.

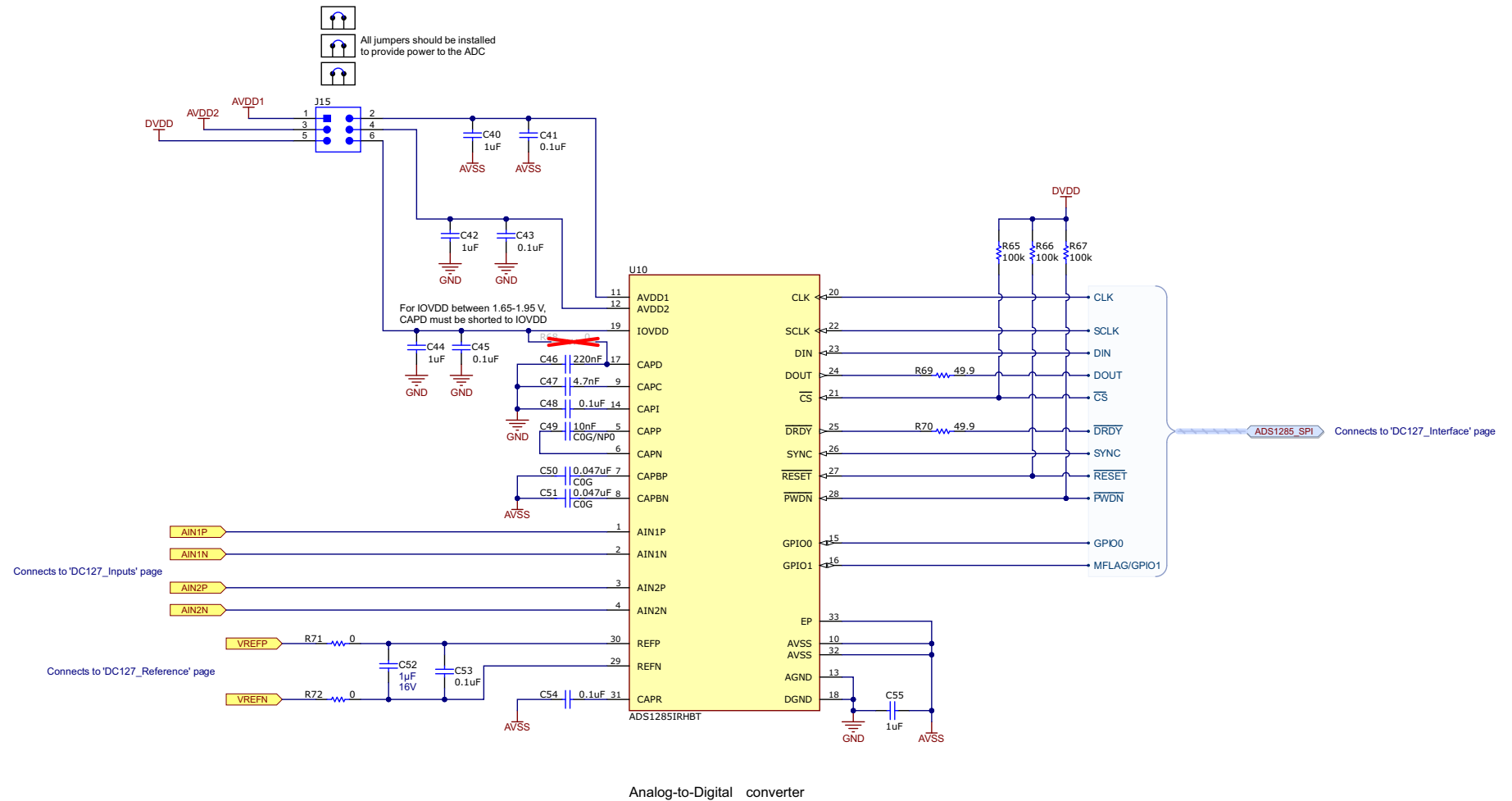


Figure 9-8. ADS1285EVM-PDK ADC Schematic

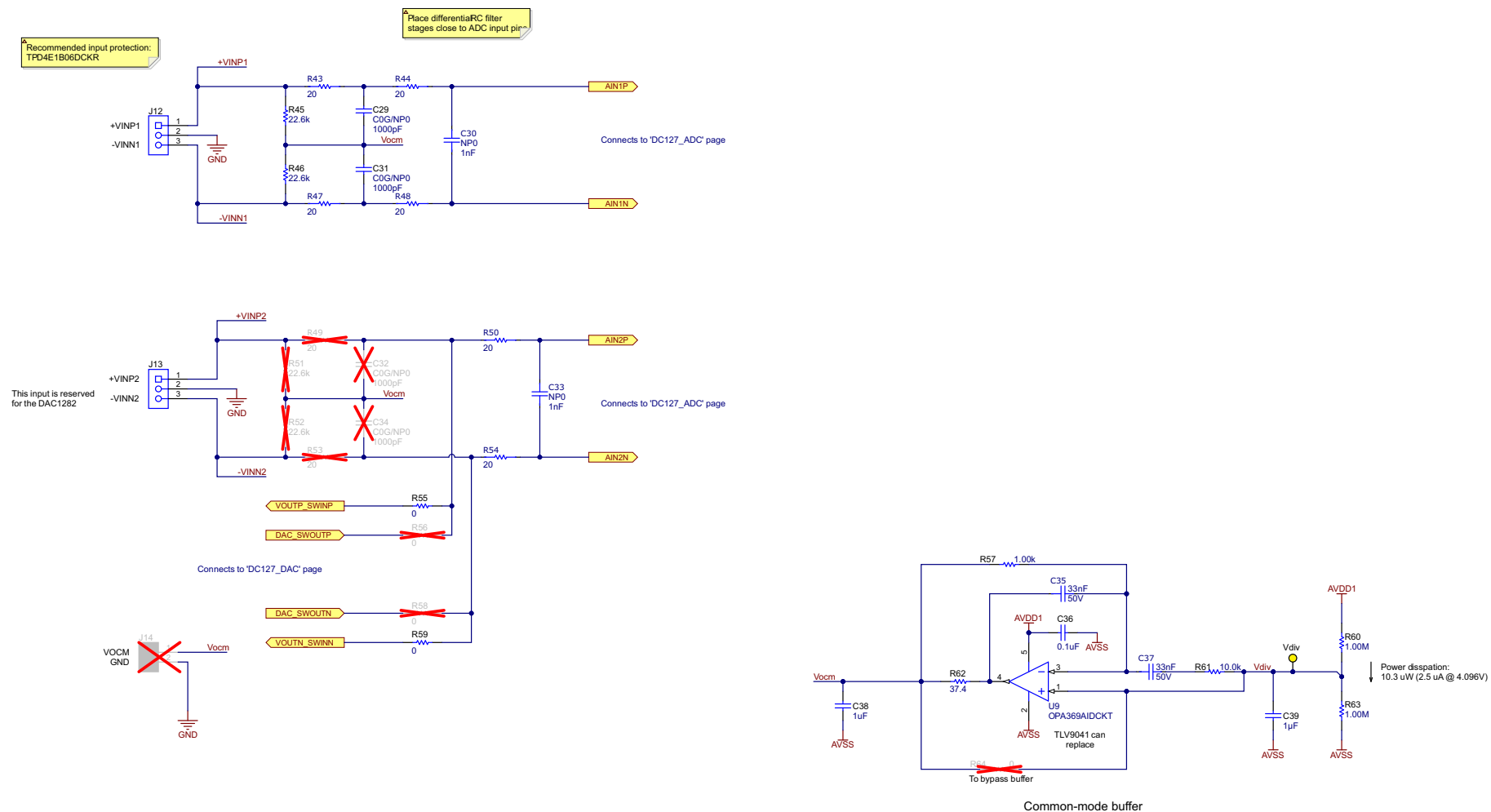


Figure 9-9. ADS1285EVM-PDK Analog Inputs and Common-Mode Buffer Schematic

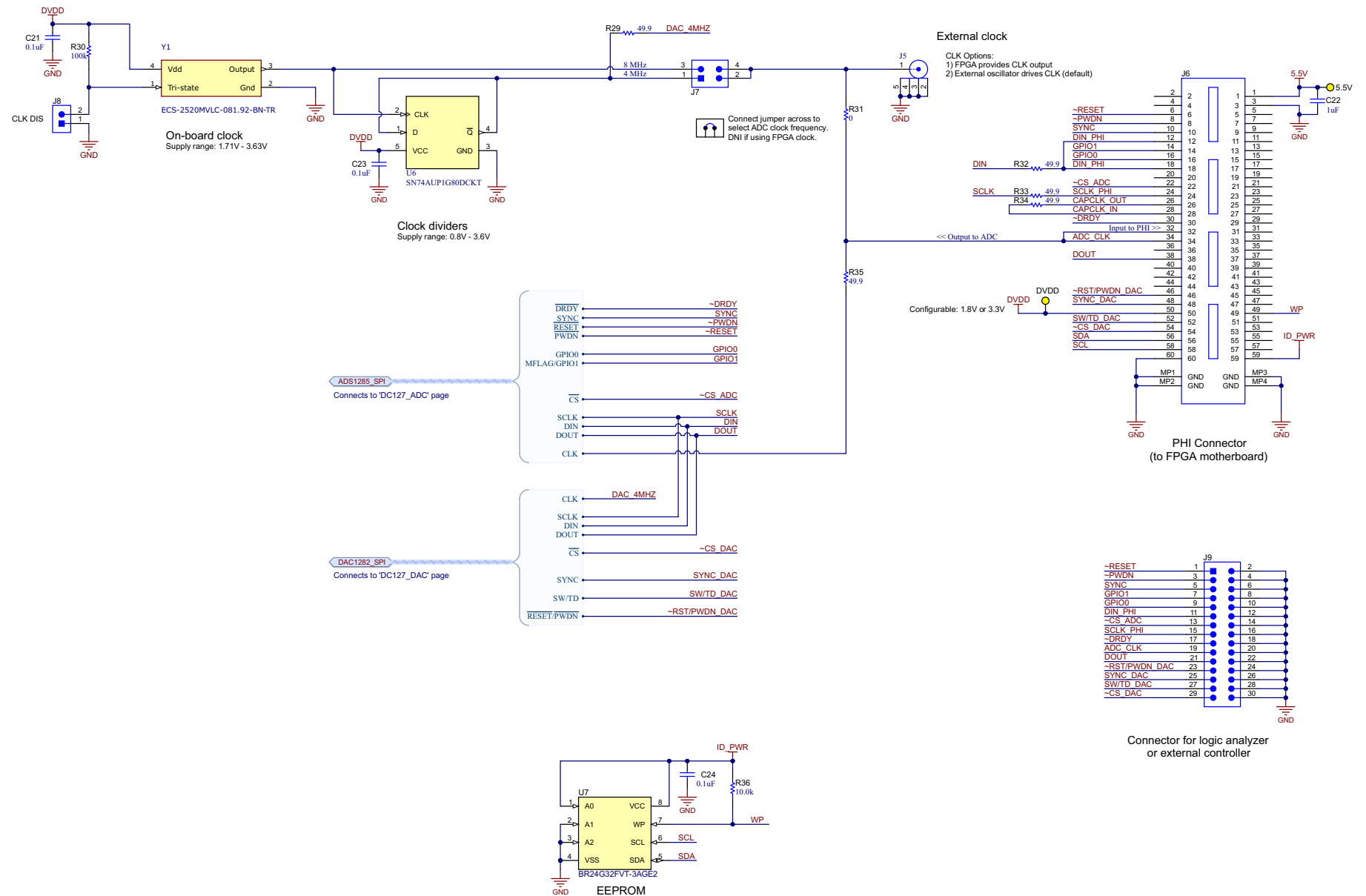


Figure 9-10. ADS1285EVM-PDK Clock and Interface Schematic

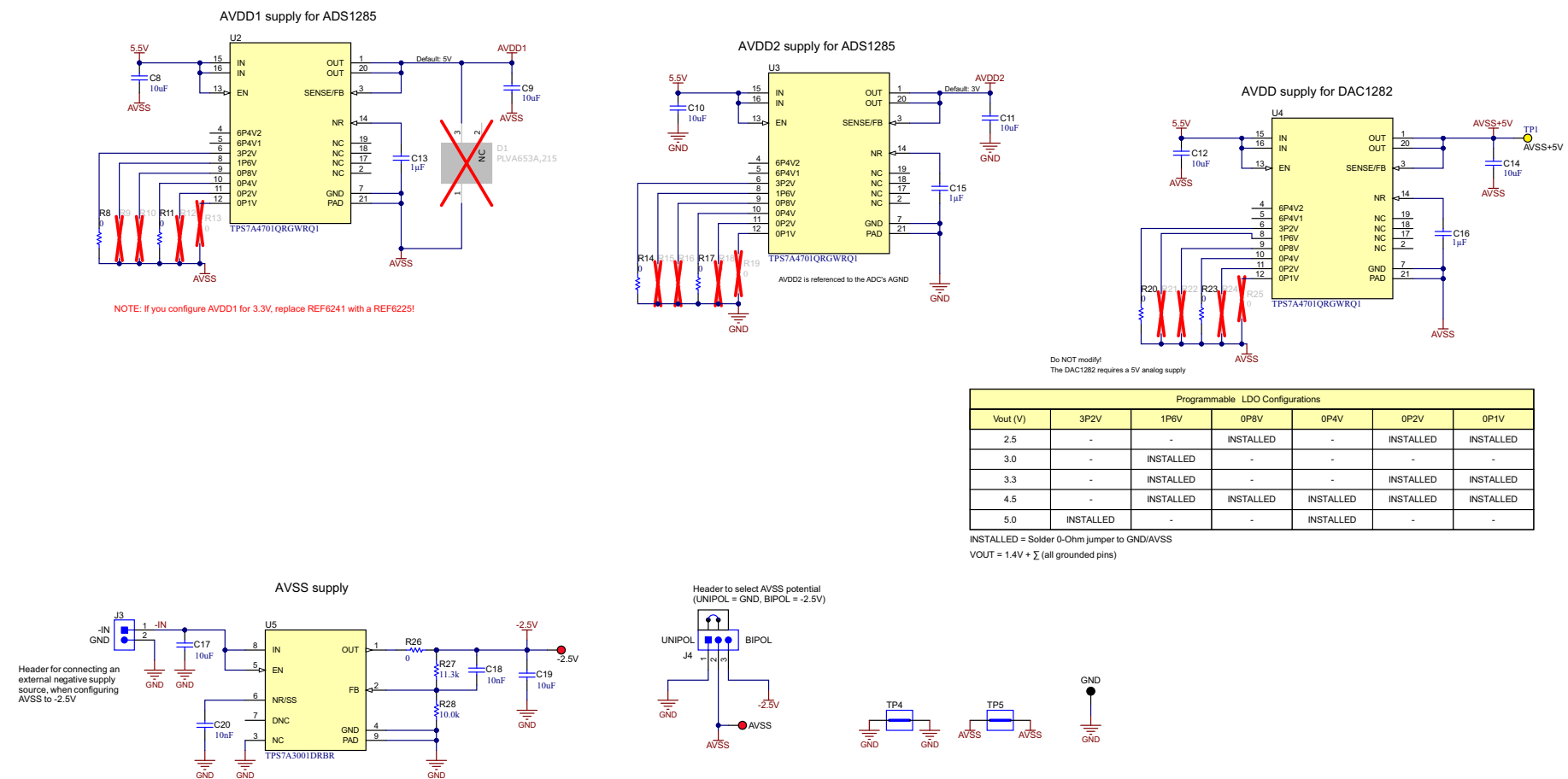


Figure 9-11. ADS1285EVM-PDK Power-Supply Schematic

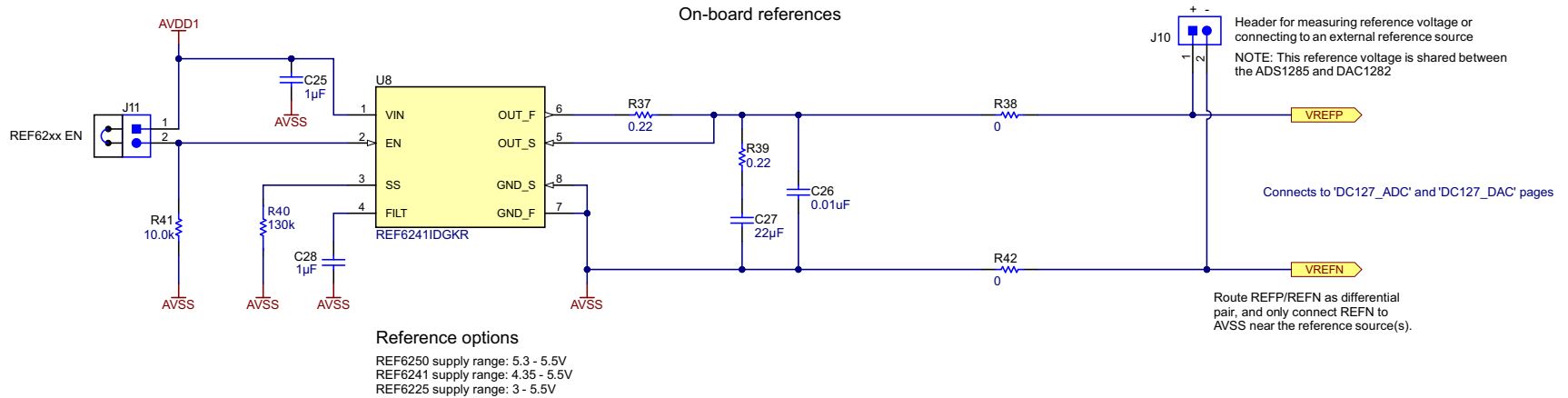


Figure 9-12. ADS1285EVM-PDK Reference Voltage Schematic

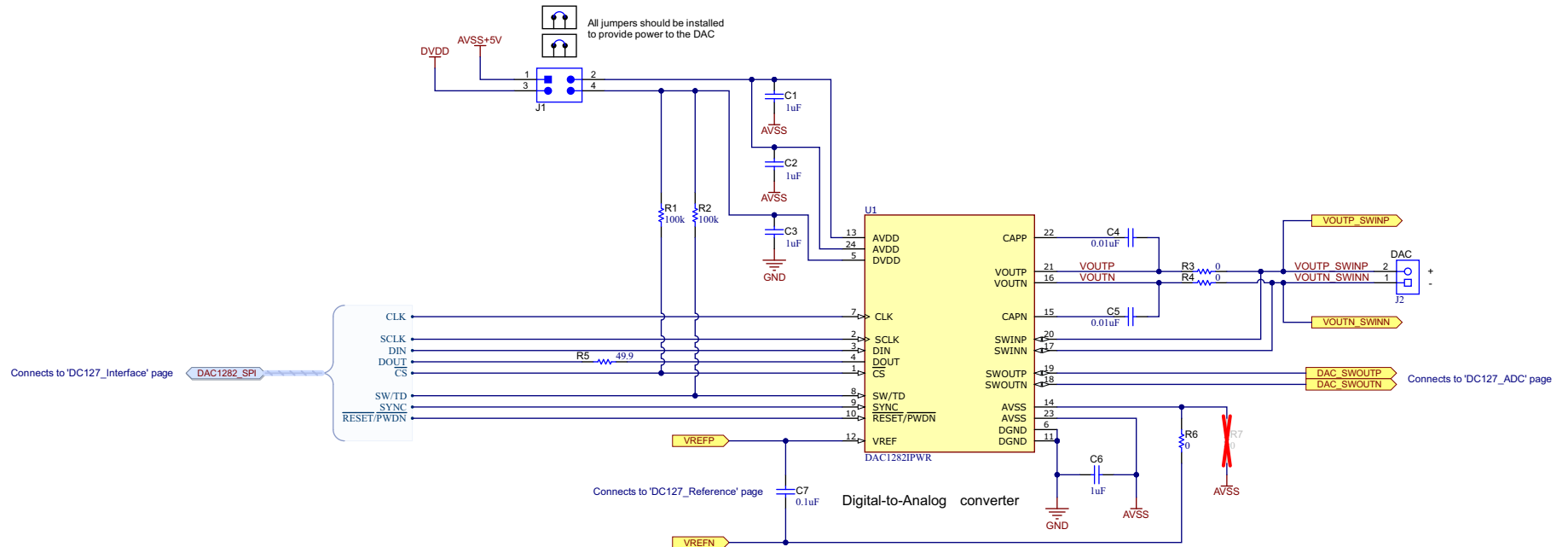


Figure 9-13. ADS1285EVM DAC Schematic

10 References

- Texas Instruments, [DAC1282 Low Distortion Digital-to-Analog Converter for Seismic data sheet](#)
- Texas Instruments, [REF62xx High-Precision Voltage Reference With Integrated ADC Drive Buffer data sheet](#)

11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision * (April 2022) to Revision A (September 2022)	Page
• Changed document to align with new evaluation module.....	1

STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductor products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
2. *Limited Warranty and Related Remedies/Disclaimers:*
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGRADATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

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3.4 European Union

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.

6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.

7. *USER'S INDEMNITY OBLIGATIONS AND REPRESENTATIONS.* USER WILL DEFEND, INDEMNIFY AND HOLD TI, ITS LICENSORS AND THEIR REPRESENTATIVES HARMLESS FROM AND AGAINST ANY AND ALL CLAIMS, DAMAGES, LOSSES, EXPENSES, COSTS AND LIABILITIES (COLLECTIVELY, "CLAIMS") ARISING OUT OF OR IN CONNECTION WITH ANY HANDLING OR USE OF THE EVM THAT IS NOT IN ACCORDANCE WITH THESE TERMS. THIS OBLIGATION SHALL APPLY WHETHER CLAIMS ARISE UNDER STATUTE, REGULATION, OR THE LAW OF TORT, CONTRACT OR ANY OTHER LEGAL THEORY, AND EVEN IF THE EVM FAILS TO PERFORM AS DESCRIBED OR EXPECTED.

8. *Limitations on Damages and Liability:*

8.1 *General Limitations.* IN NO EVENT SHALL TI BE LIABLE FOR ANY SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL, OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF THESE TERMS OR THE USE OF THE EVMS , REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO, COST OF REMOVAL OR REINSTALLATION, ANCILLARY COSTS TO THE PROCUREMENT OF SUBSTITUTE GOODS OR SERVICES, RETESTING, OUTSIDE COMPUTER TIME, LABOR COSTS, LOSS OF GOODWILL, LOSS OF PROFITS, LOSS OF SAVINGS, LOSS OF USE, LOSS OF DATA, OR BUSINESS INTERRUPTION. NO CLAIM, SUIT OR ACTION SHALL BE BROUGHT AGAINST TI MORE THAN TWELVE (12) MONTHS AFTER THE EVENT THAT GAVE RISE TO THE CAUSE OF ACTION HAS OCCURRED.

8.2 *Specific Limitations.* IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMNITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, , EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.

9. *Return Policy.* Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.

10. *Governing Law:* These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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